



# Status of HiLASE project



**Tomáš Mocek**  
**Chief Scientist & Project Manager**

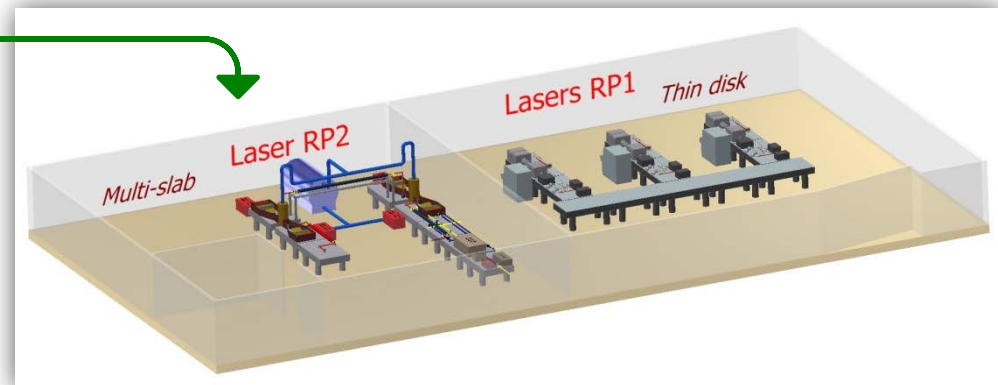
# Synopsis



- Project led by the Institute of Physics
- Financed by the Research and Development for Innovation Operational Program (ERDF)
- Research center of international importance
- Applications of DPSSL in high-tech industry
- Lasers with breakthrough parameters
- Synergy with ELI Beamlines

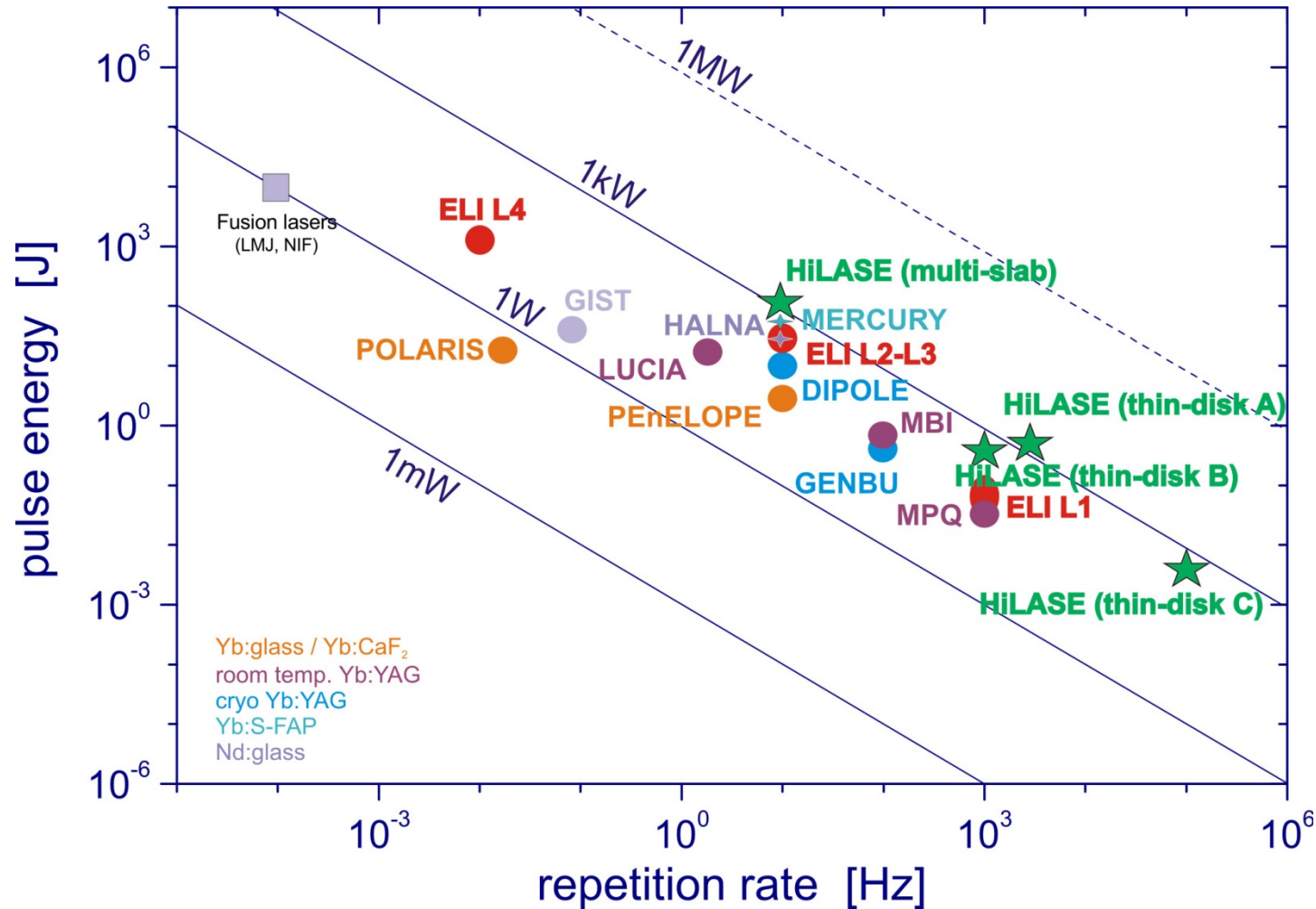


Future HiLASE building



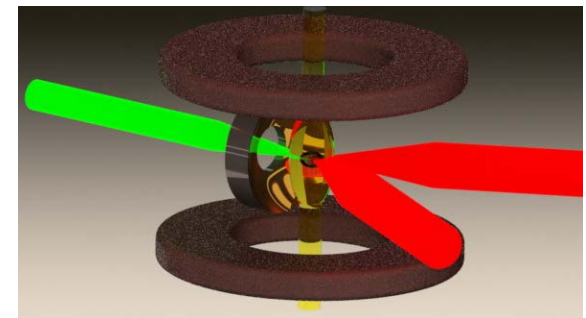
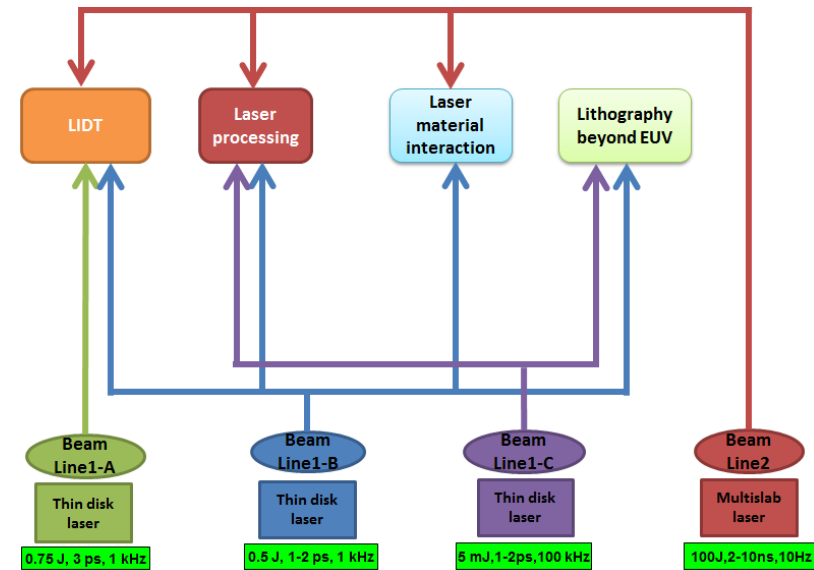
Laser technologies

# Aiming very high



# High-tech industrial applications

- Laser induced damage threshold measurement of optical materials
- Laser shock peening
- Compact X-ray sources for lithography
- Precise cutting, drilling and welding of special materials for automotive and aerospace industry
- Technology of laser micromachining
- Laser paint stripping, surface cleaning



# In line with current trends in Europe



## TOWARDS 2020 – PHOTONICS DRIVING ECONOMIC GROWTH IN EUROPE

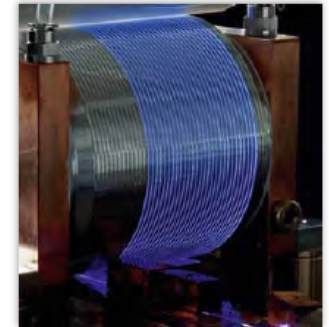
Multiannual Strategic Roadmap 2014–2020



●●● PHOTONICS<sup>21</sup>

Left: 3D laser cutting.  
© TRUMPF

Right: Thin-disk, laser-pumped  
high-brightness fibre laser developed  
at the IFSW for material processing  
applications. © IFSW, University  
of Stuttgart



Therefore, more efficient lasers and new photonic components will be needed, including:

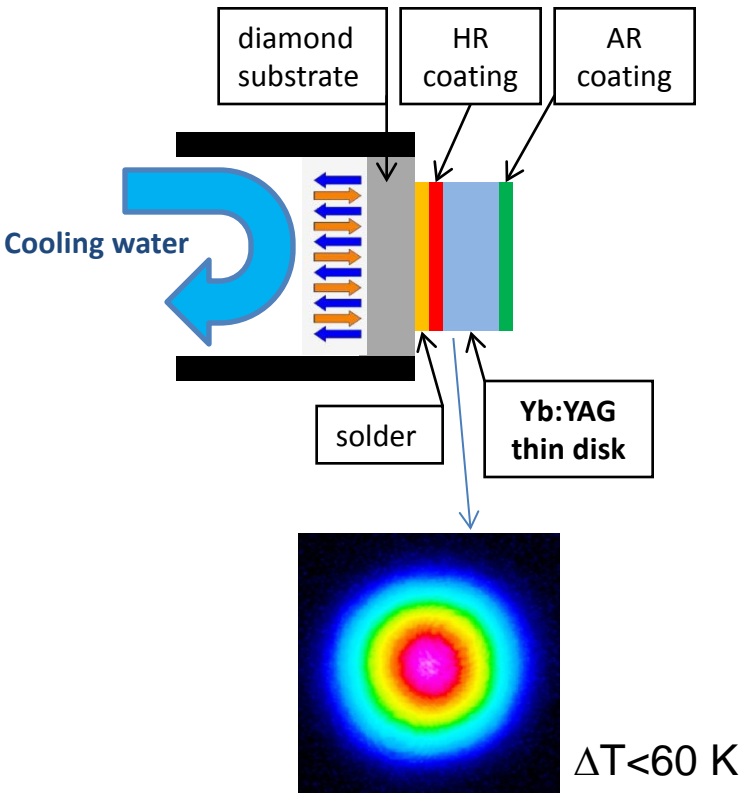
- high brilliance diode lasers (output power >20W per emitter) with improved energy efficiency and beam quality
- ultra high power (>1kW), ultra short pulse (fs-ps), visible and near IR lasers
- highly efficient and long term stable UV/EUV lasers (solid state)
- cw UV direct imaging (with 100W)
- 'fully tunable' laser (pulse width tailored to the application and variable in wavelength – UV to visible to MIR)
- efficient mid-infrared laser with output power up to 1kW (e.g. 1.5–1.9  $\mu\text{m}$  / 2.6–4  $\mu\text{m}$  for organic materials/polymers)
- industrial MIR systems
- coatings and components (e.g. gratings, isolators) for high power/high intensity beams
- non-linear transparent materials (crystals, ceramics) for high power/high intensities (and short/UV wavelengths)
- fast modulation capability provided in conjunction with high speed scanning devices (for synchronisation)

In the drive for higher product quality, further development and production implementation will be needed for beam delivery and control, process monitoring, adaptive control of the laser manufacturing process, and quality inspection of laser manufactured goods. Aspects of integrating laser sources within machine tools, in particular robotic manufacturing tools, will also require optimisation and standardisation. This will require that the following technological challenges be addressed for beam delivery, shaping and deflection systems:

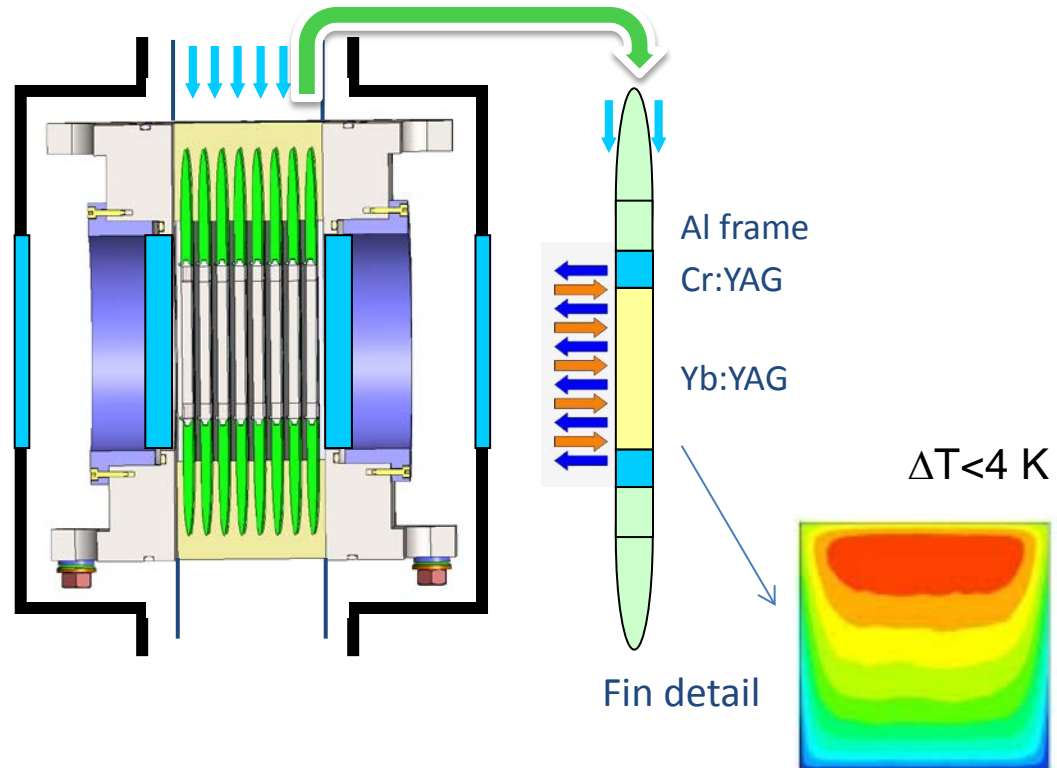
- remote technologies
- connectors and integrated beam switches
- monitored high power connectors
- diffraction limited fibre delivery of output power >1kW over a distance of 100m
- laser arrays, multiple fibre arrays, and fibres for transport of ultra-short/energetic pulses
- precise beam deflection with a target speed of 1km/s (at the work piece)
- dynamically reconfigurable intensity distributions for advanced thermal management of laser processes e.g. for welding or soldering
- new electro optic materials, beam delivery systems, and fast electronics and data processing
- standardised modular systems

# Upscaling novel geometries

### Thin disk



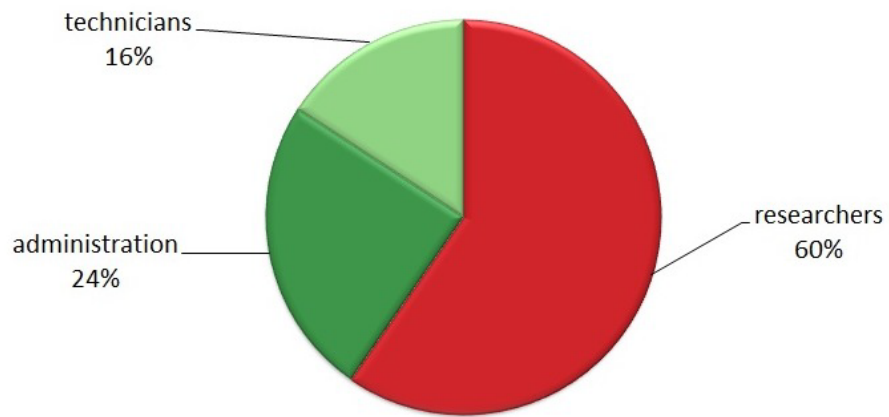
### Multi-slab



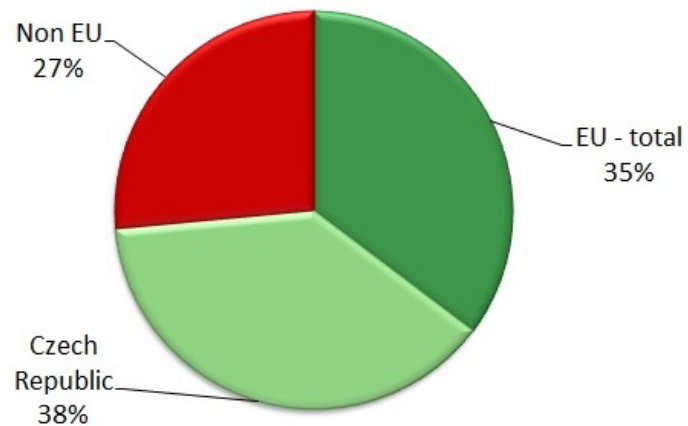
# International Team



### HiLASE team



### HiLASE research team



# Time schedule: 18 months ahead



01-08/2015

09/2015

03-06/2014

01-03/2013

09/2012

10/2011

09/2011

Decision on grant

Start of procurement and in-house R&D of key laser systems, incl. construction

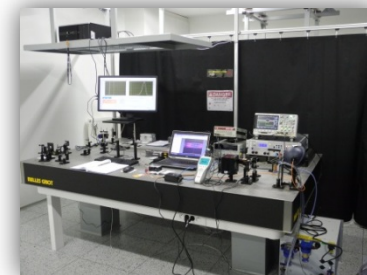
Start of construction of new building

Signing contracts for key laser systems

End of construction, relocation from Prague to Dolní Břežany

Installation and optimization of key laser systems

Commissioning of HiLASE R&D Centre





# HiLASE Cornerstone laying ceremony



October 9, 2012



# Progress of construction: 12/2013



# Visit of EU Commissioner for Research, Innovation and Science



October 18, 2013

# 02/2014: Mid-term Review



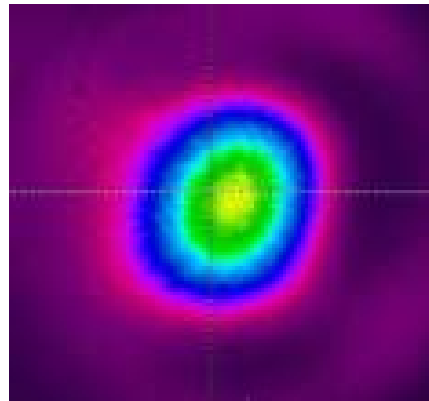
# Ready to move



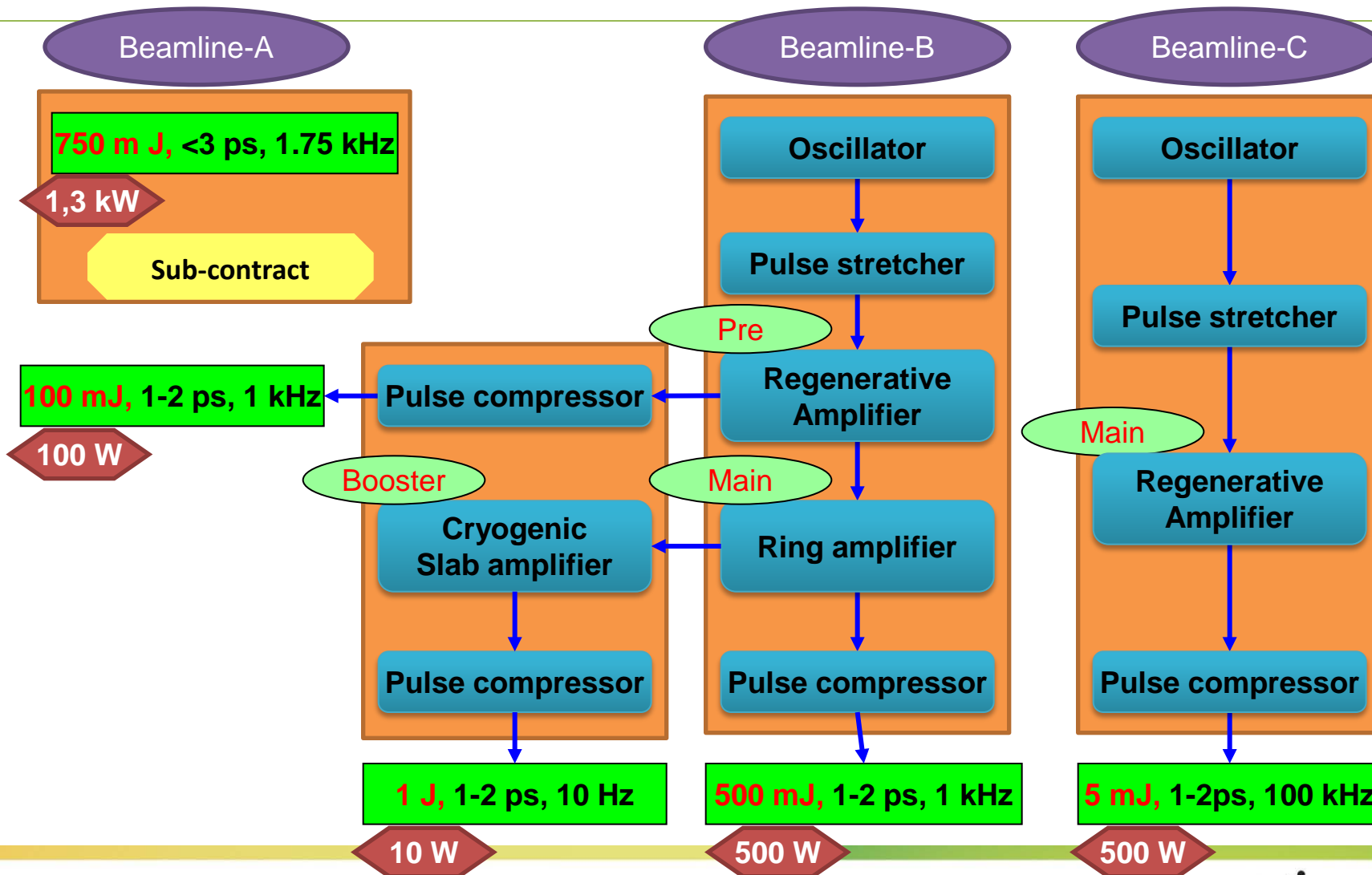
March 25, 2014



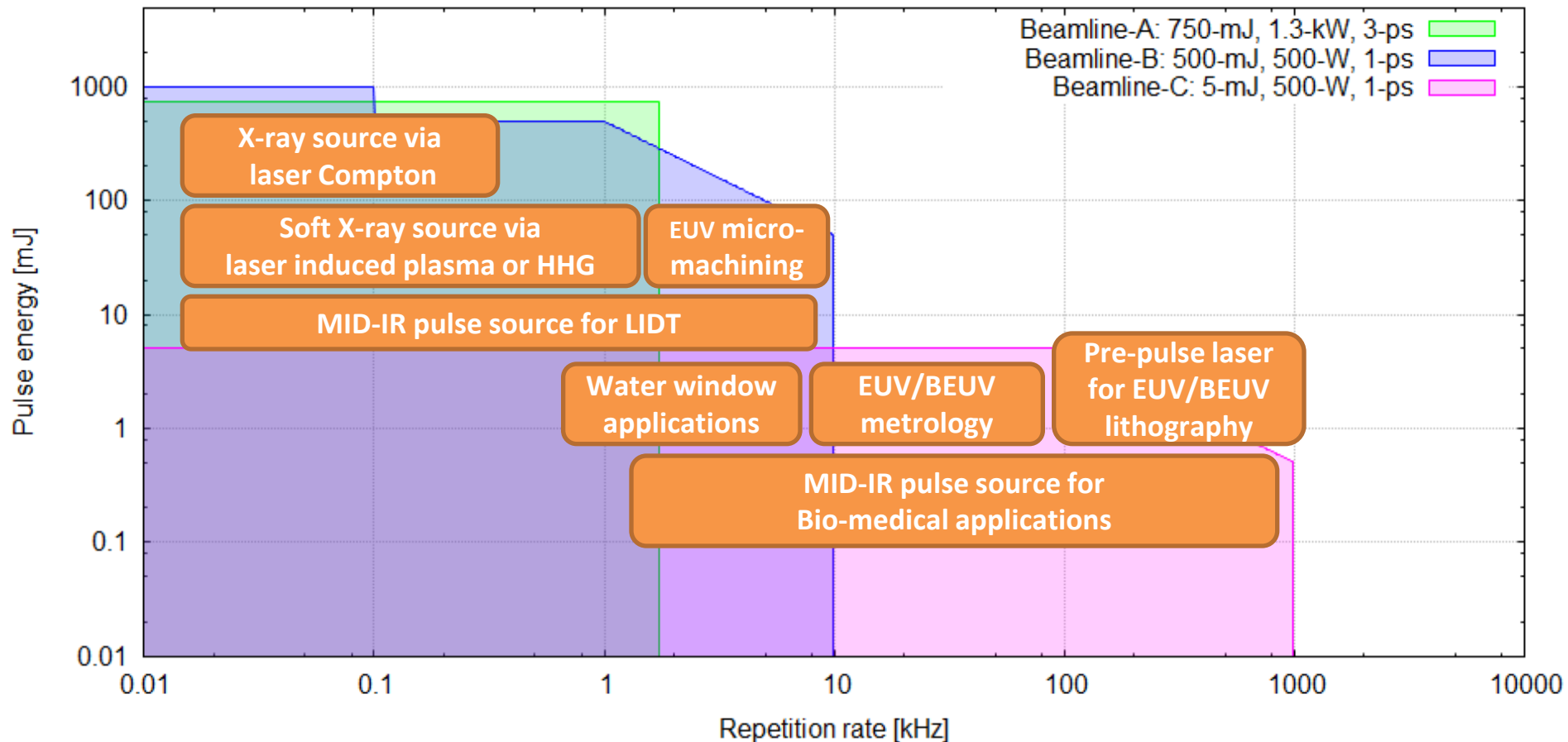
## Development of multi-J, kW class thin-disk laser system (L1)



# Concept of kW-class thin-disk DPSSL



# Applications of our thin-disk lasers





# Design of new EUV source

➤ Continuous dense gas jet target



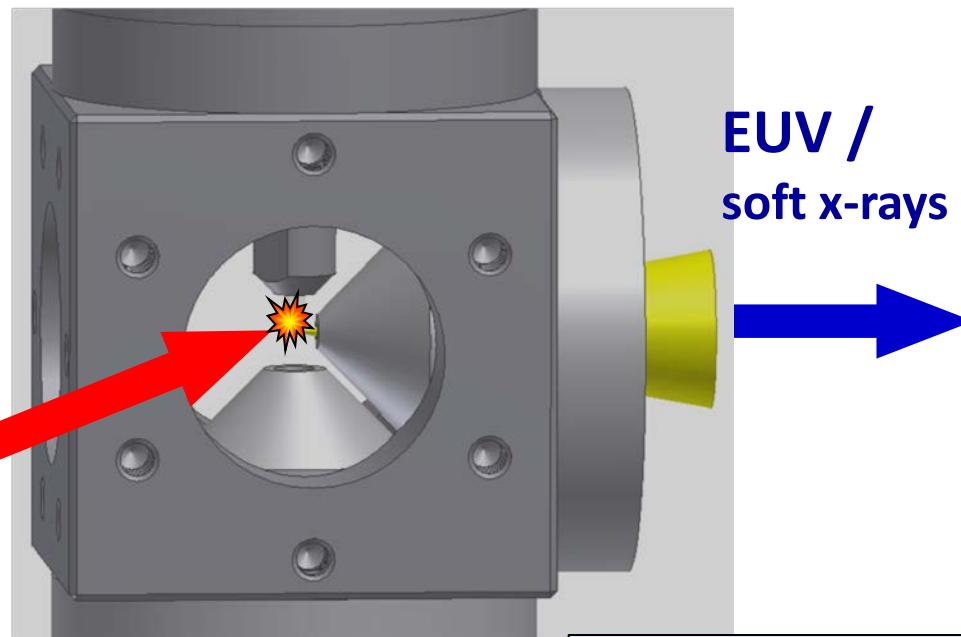
Xe, Kr, N<sub>2</sub>  
Differential pumping

Beamline B

ps laser  
500 W

0.5 J, 1-2 ps, 1 kHz

( 0.5J, 8ns, 5Hz )



- high brilliance
- low debris

# Pre-pulse Laser for HVM EUV Lithography

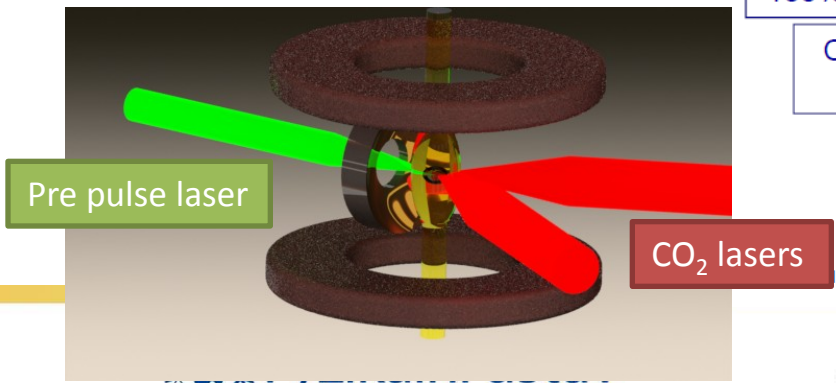
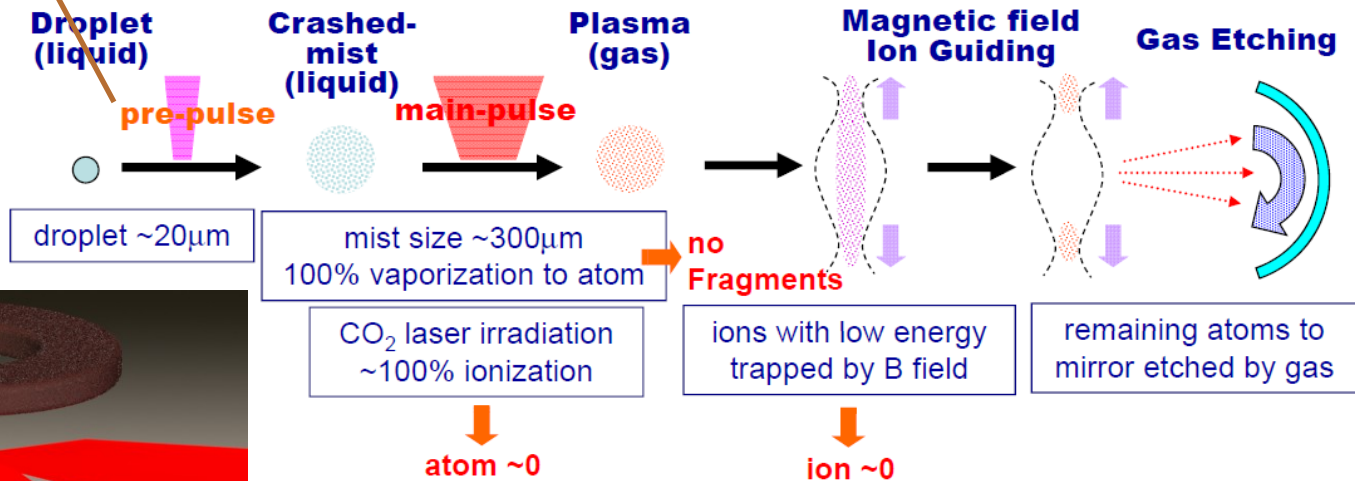


- Solid-state laser
- 3.3 mJ
- 150 kHz
- (500 W)
- <10 ps

## Debris mitigation concept

- Double pulse laser irradiation
- Magnet field is effective for guiding ions
- Gas etching

Beamline C



**KOMATSU**

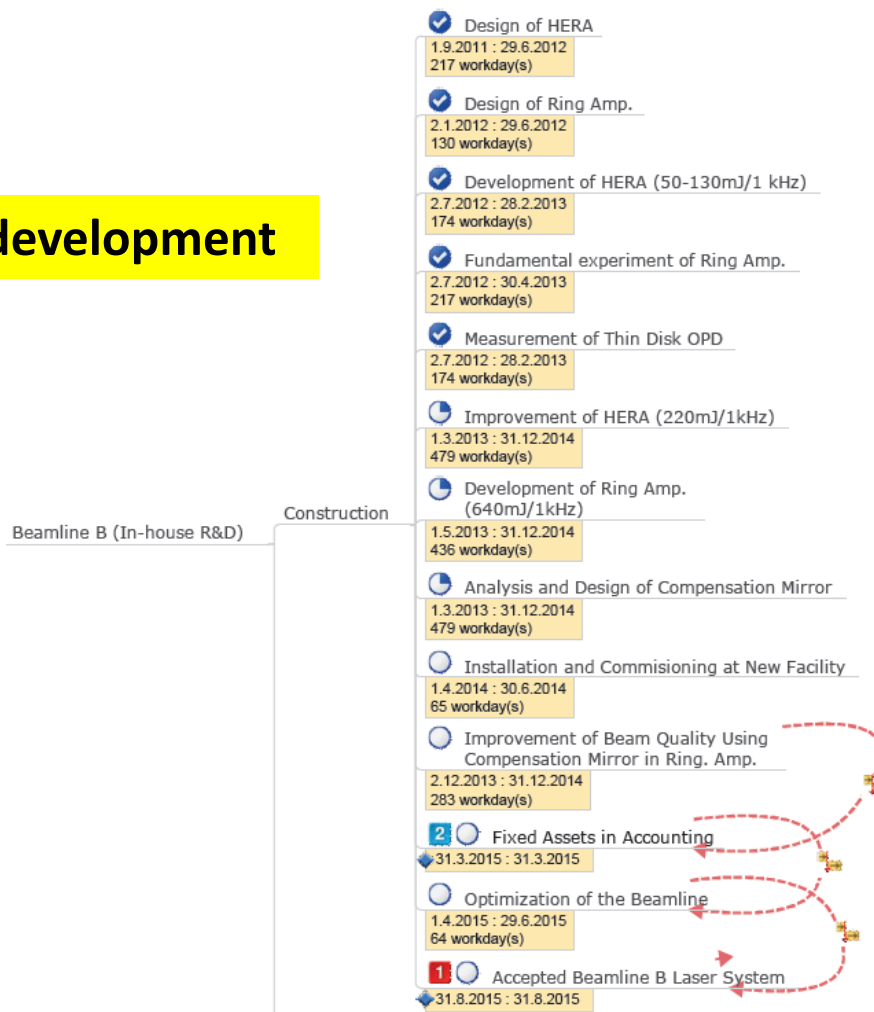
[8322-14] SPIE 2012 Advanced Lithography, February 14, 2012, P11



# Beamlines L1-B/C in progress



100% In-house development

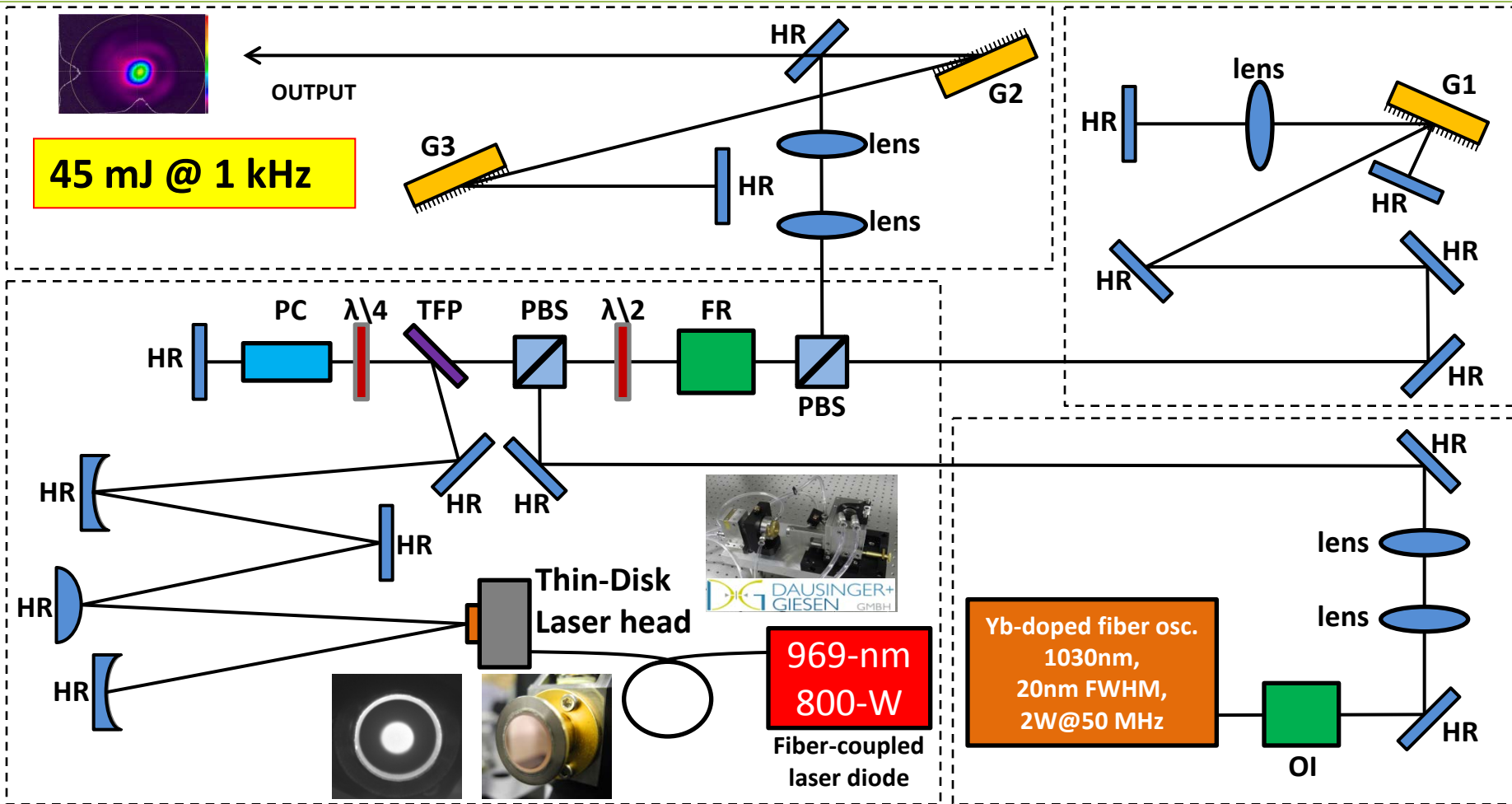


# High Energy Regenerative Amplifier With pulsed zero-phonon-line pumping



COMPRESSOR

STRETCHER



45 mJ @ 1 kHz

OUTPUT

REGENERATIVE AMPLIFIER

FRONT-END

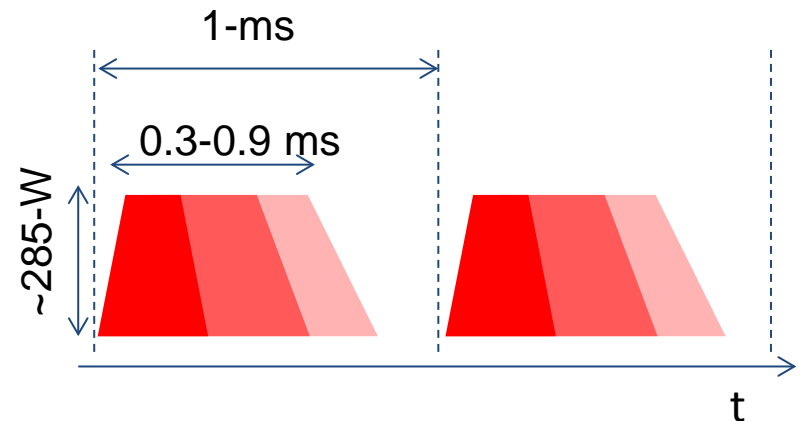


# 940-nm Pulsed Pumping in 1-kHz Regenerative Amplifier



**30 mJ, eff. 12.2 %**

Pump  
Pulse  
Length  
900  $\mu$ s



**30 mJ, eff. 15.7 %**

Pump  
Pulse  
Length  
700  $\mu$ s

**24 mJ, eff. 19 %**

Pump  
Pulse  
Length  
500  $\mu$ s

## Optimization of beam quality and optical-to-optical efficiency of Yb:YAG thin-disk regenerative amplifier by pulsed pumping

Michal Chyla,<sup>1,2,\*</sup> Taisuke Miura,<sup>1</sup> Martin Smrz,<sup>1</sup> Helena Jelinkova,<sup>2</sup> Akira Endo,<sup>1</sup> and Tomas Mocek<sup>1</sup>

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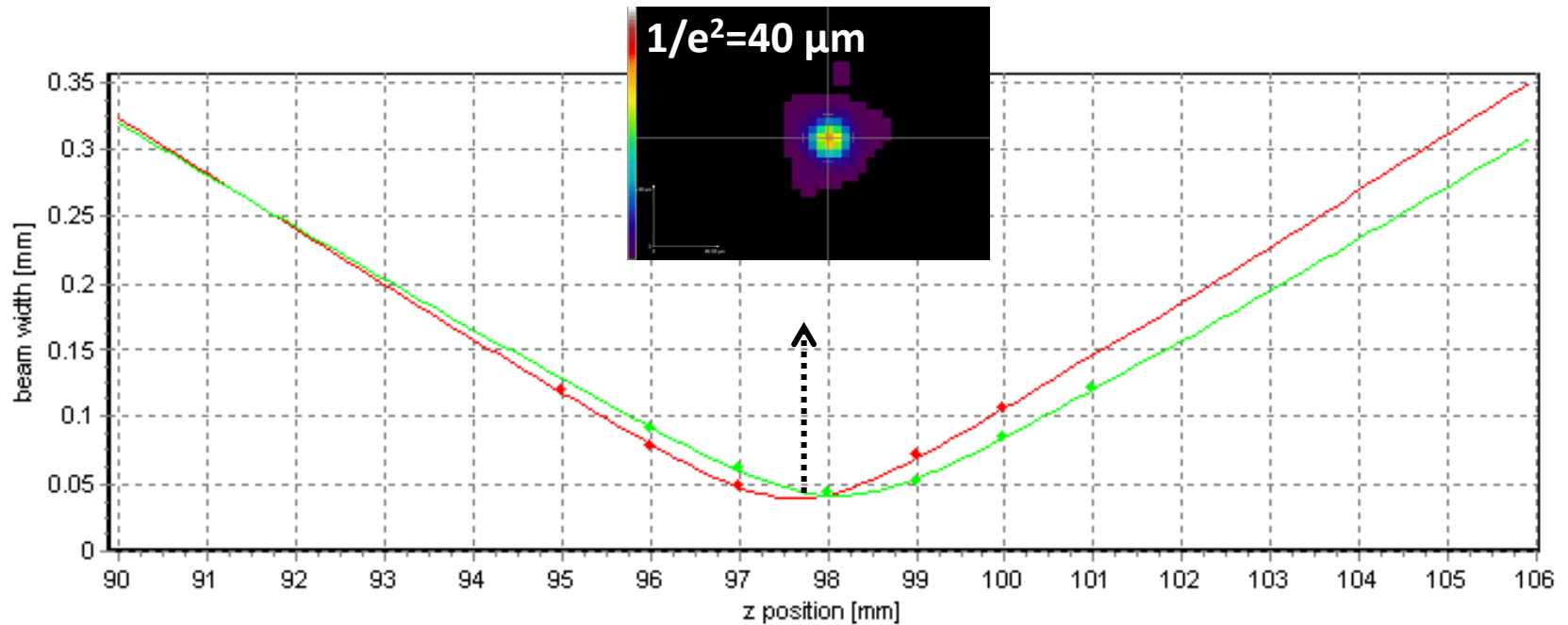
Received December 13, 2013; accepted January 21, 2014;  
posted January 31, 2014 (Doc. ID 203036); published 0 MONTH 0000

We demonstrate an optimization method of beam quality and optical-to-optical (O-O) efficiency by using pulsed pumping. By changing the pulse duration and the peak intensity of pump pulse at the repetition rate of 1 kHz, the beam quality and O-O efficiency of the Yb:YAG thin-disk regenerative amplifier can be improved. We applied this method to the regenerative amplifier under the pumping wavelength of both 940 and 969 nm, and found that the method was effective in both pumping wavelengths. Although a Yb:YAG thin disk soldered on a copper tungsten heat sink, which has poor thermal properties compared with a thin disk mounted on a diamond substrate, was applied as a gain media, we obtained 45 mJ output with 19.3% O-O efficiency and nearly diffraction-limited beam. © 2014 Optical Society of America

OCIS codes: (140.3280) Laser amplifiers; (140.3480) Lasers, diode-pumped; (140.3580) Lasers, solid-state; (140.3615) Lasers, ytterbium; (140.5560) Pumping; (140.3538) Lasers, pulsed.

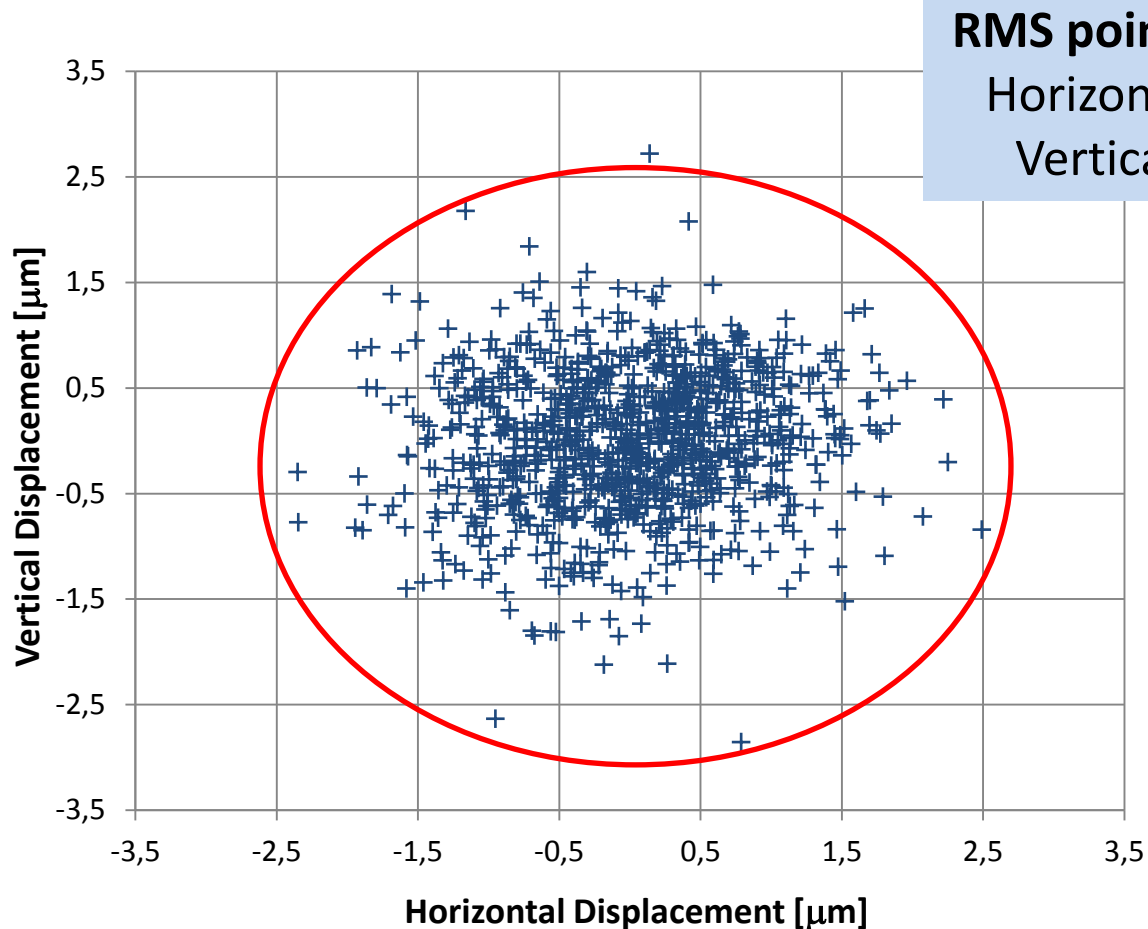
<http://dx.doi.org/10.1364/OL.99.099999>

# M<sup>2</sup> measurement of HERA



M <sup>2</sup>	
Horizontal	Vertical
1.25	1.23

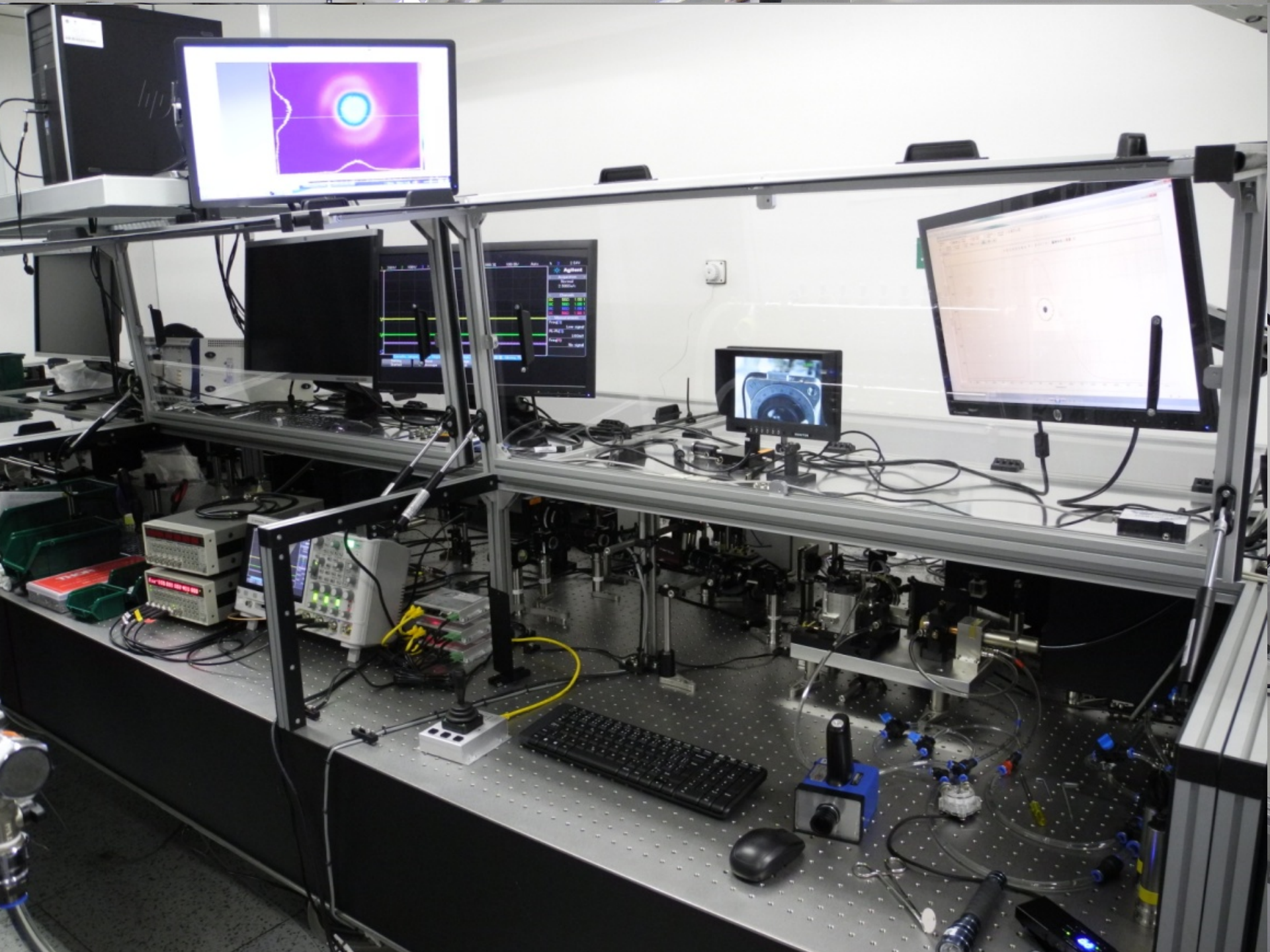
# Beam pointing stability



Measurement time: 15 min



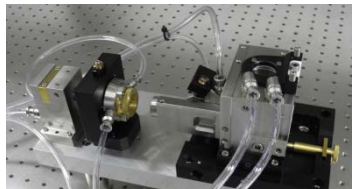
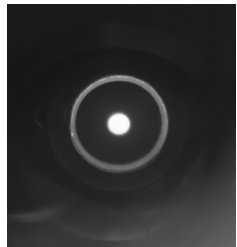




# L1-C concept

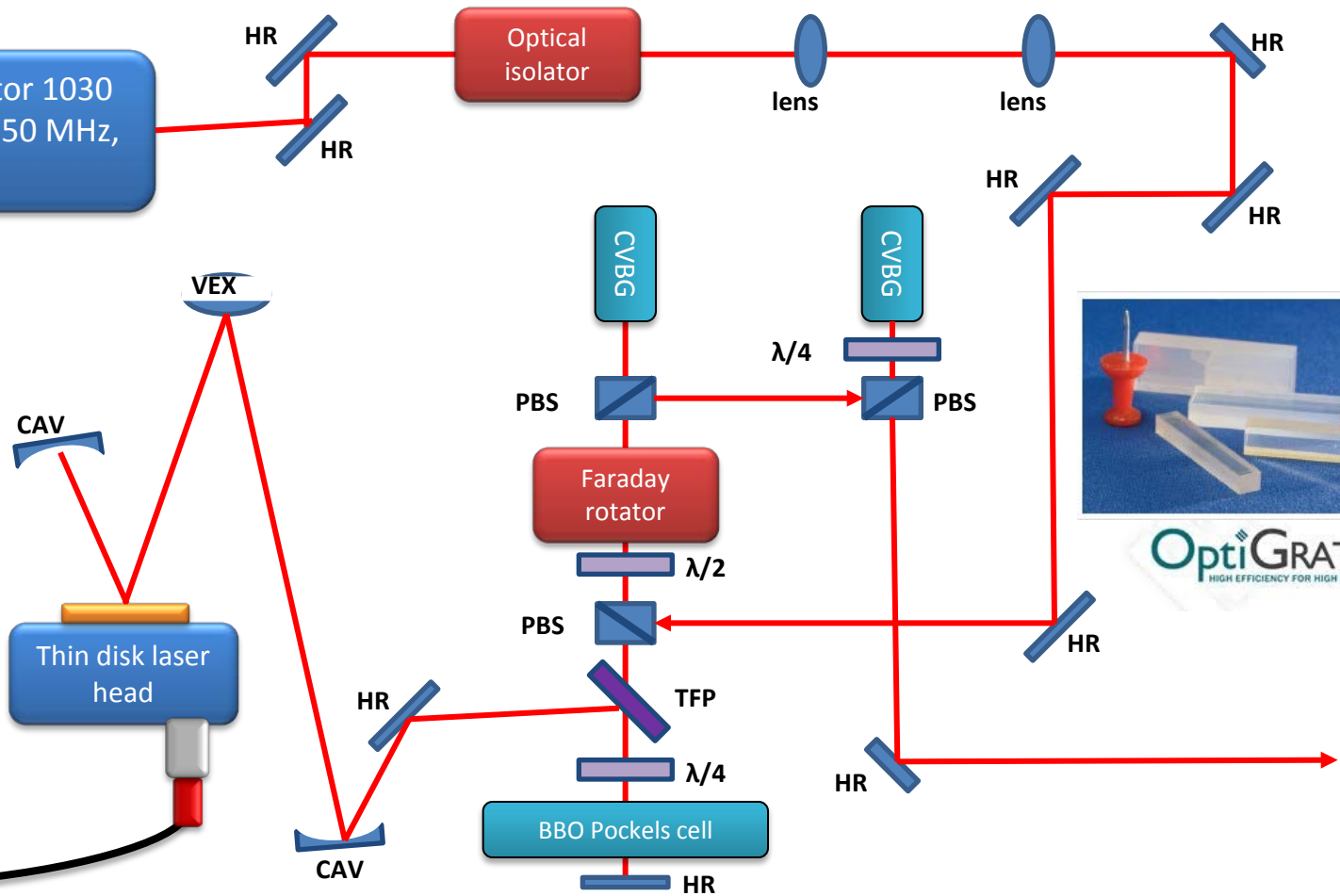


Yb doped fiber oscillator 1030 nm, FWHM 20-30 nm, 50 MHz, 40 nJ, 3-7 ps



DAUSINGER+GIESEN GMBH

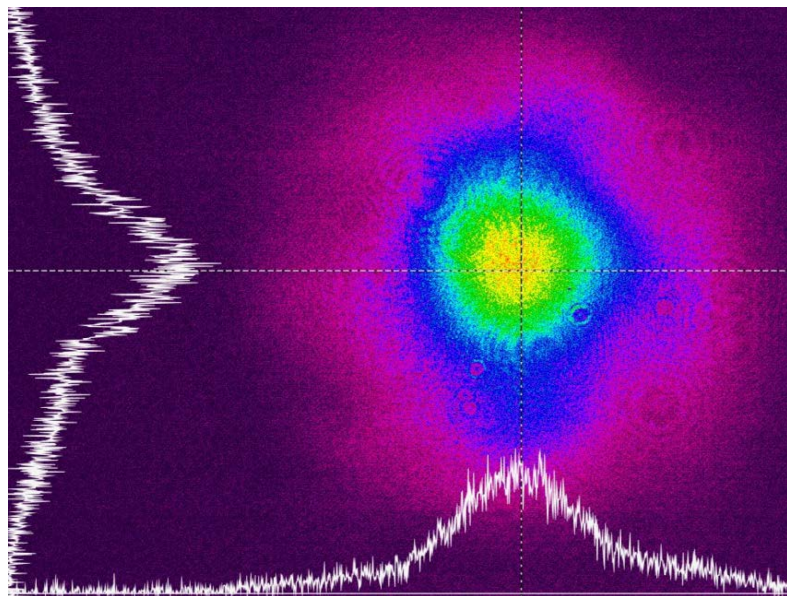
LD 969 nm, 1000 W, VBG, CW



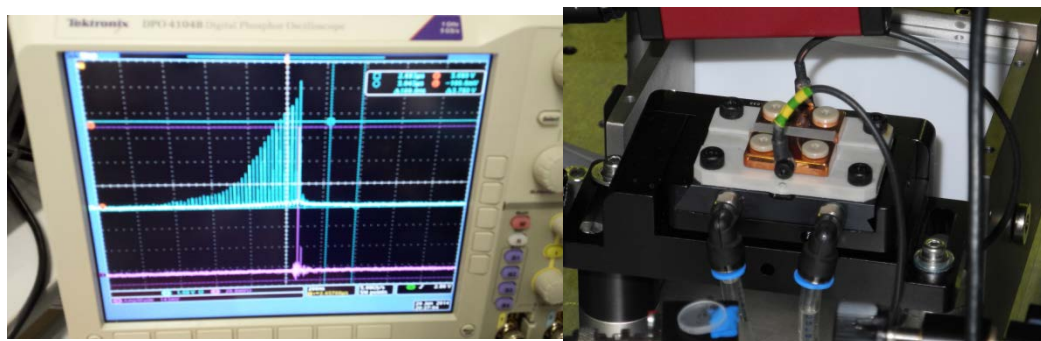
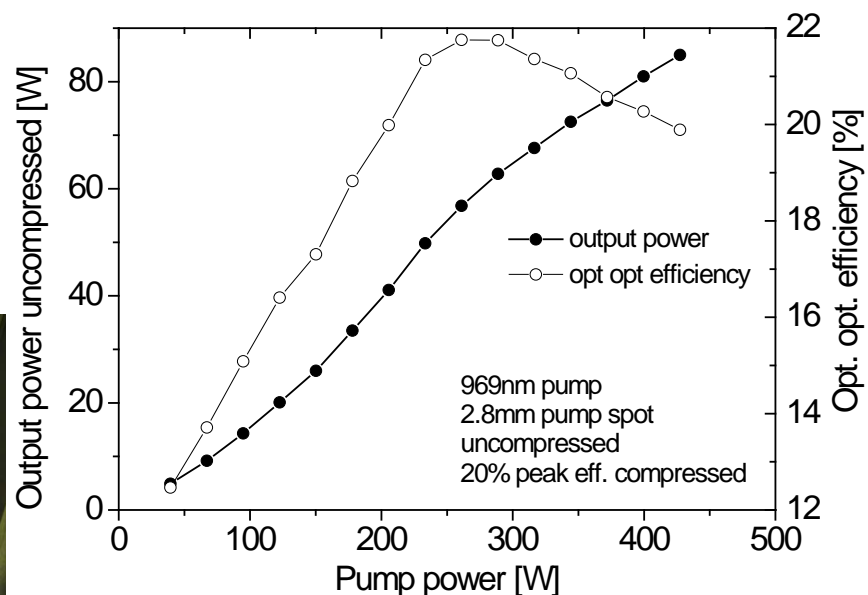
OptiGRATE HIGH EFFICIENCY FOR HIGH POWER



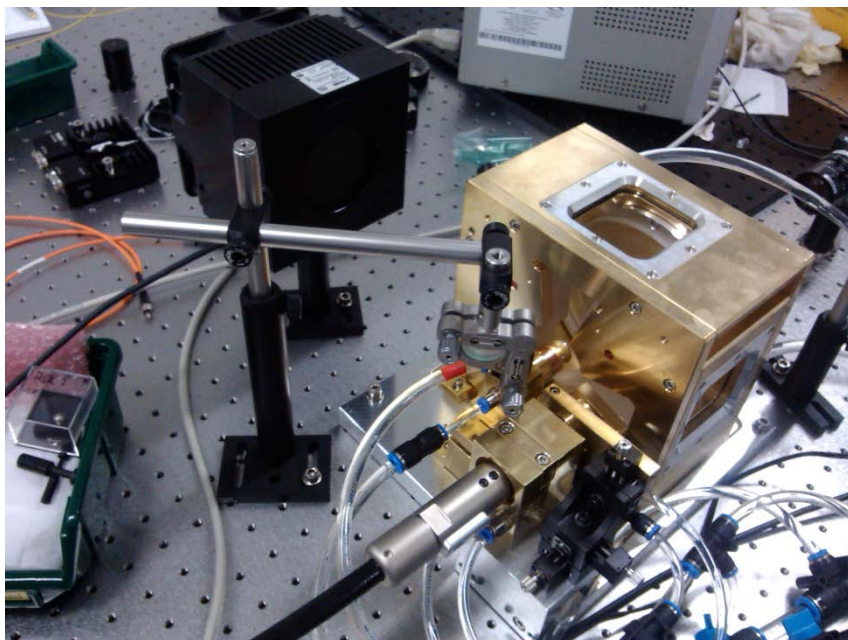
# 85 W achieved in pulsed regime



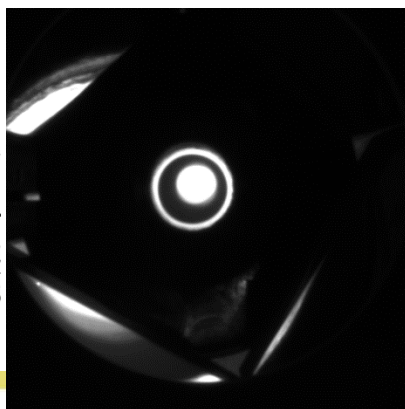
- 22% opt.opt. efficiency (uncompressed)
- 20% opt. opt. eff. Compressed (estimate)
- 85W operation (before compression)
- measured for 15C water cooling
- BBO Pockels cell (7.2kV QW voltage, 100kHz)



# High power upgrade components



**IFSW**  
UNIVERSITÄT STUTTGART  
INSTITUT FÜR STRAHLWERKZEUGE  
STUTTGART LASER TECHNOLOGIES



 **Fyzikální ústav**  
Akademie věd ČR, v. v. i.

project supported by:



EUROPEAN UNION  
EUROPEAN REGIONAL DEVELOPMENT FUND  
INVESTING IN YOUR FUTURE

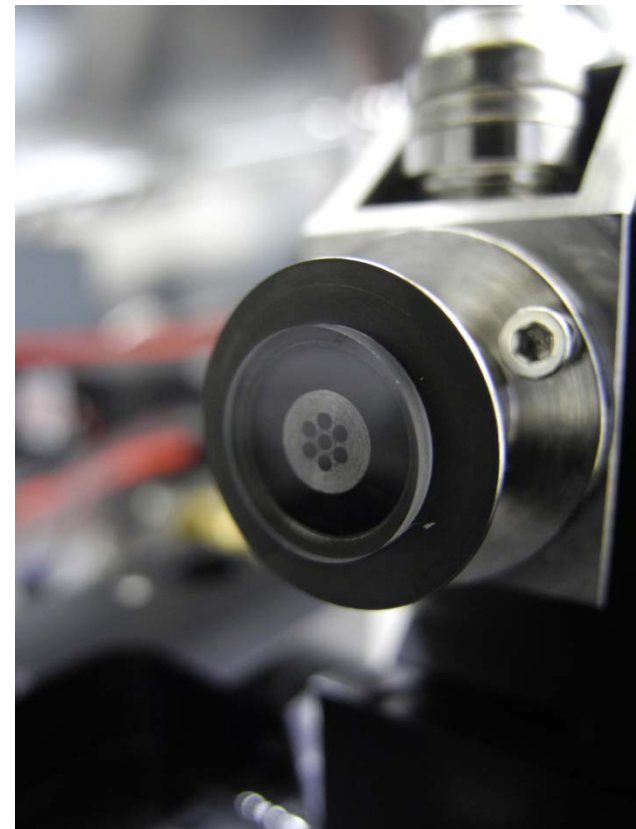
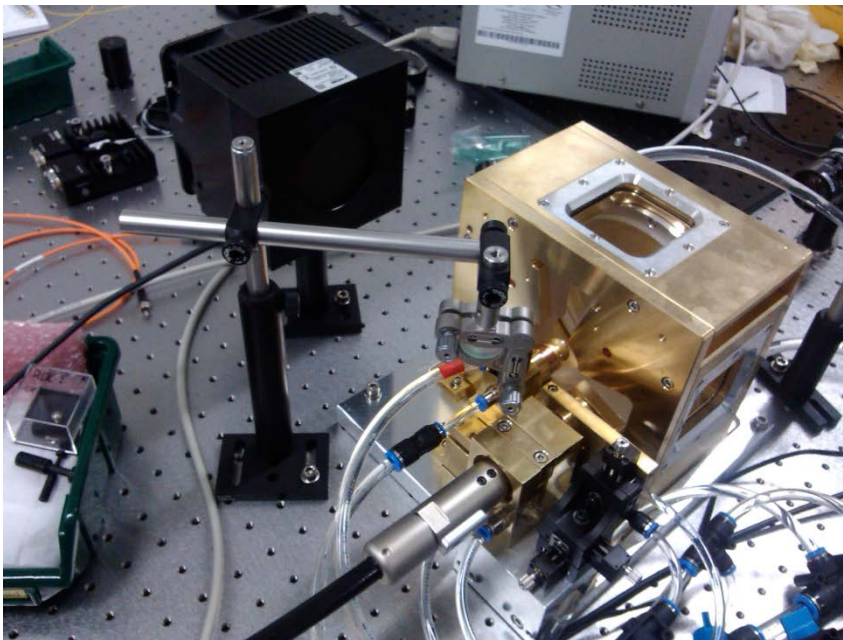


OP Research and  
Development for Innovation

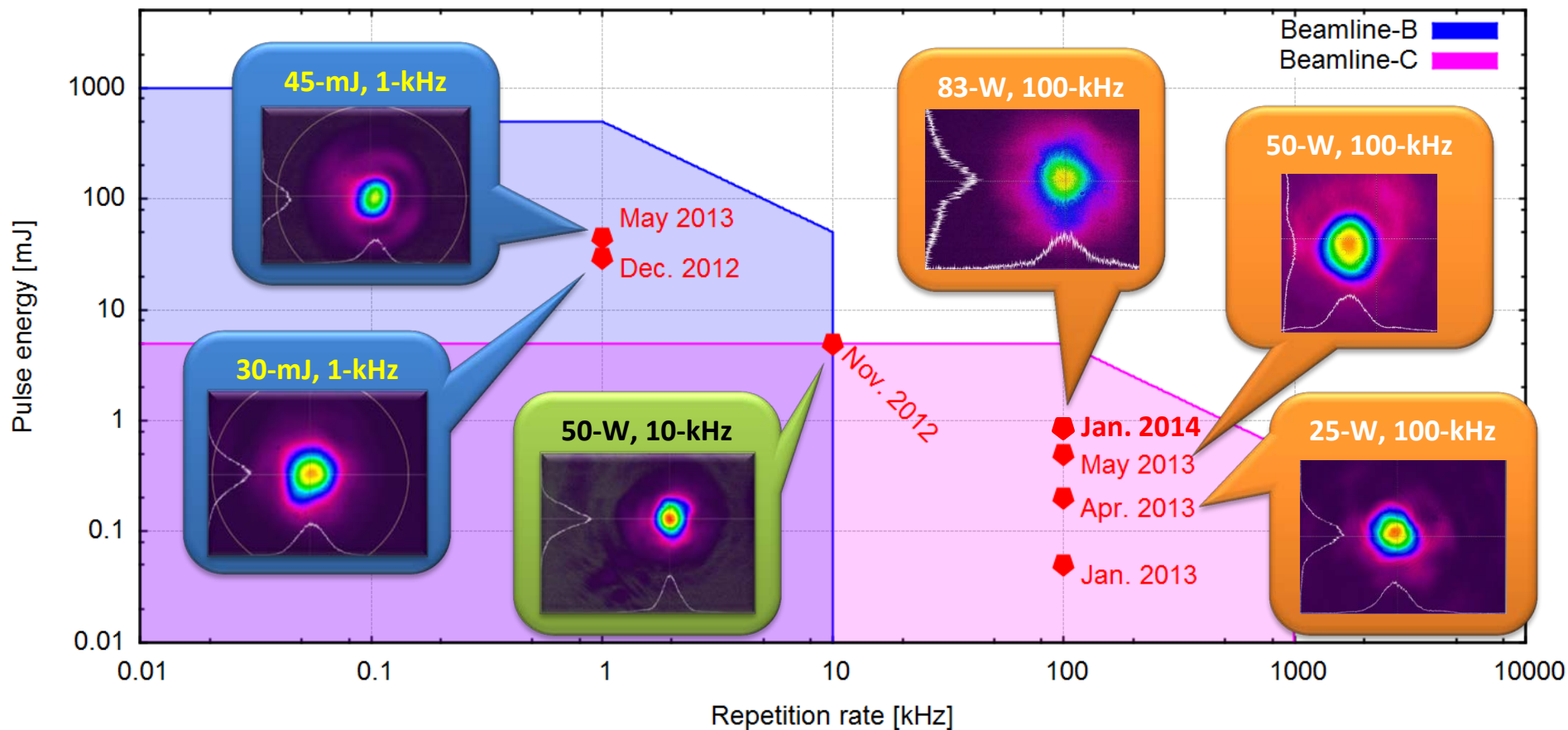
# New thin-disk substrates and materials



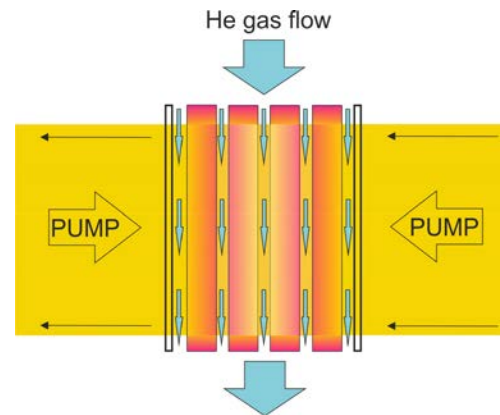
- Diamond-bonded disks
  - single crystals
  - Ceramics
  - Undoped cap
- SiC bonded disks



# Status of in-house development



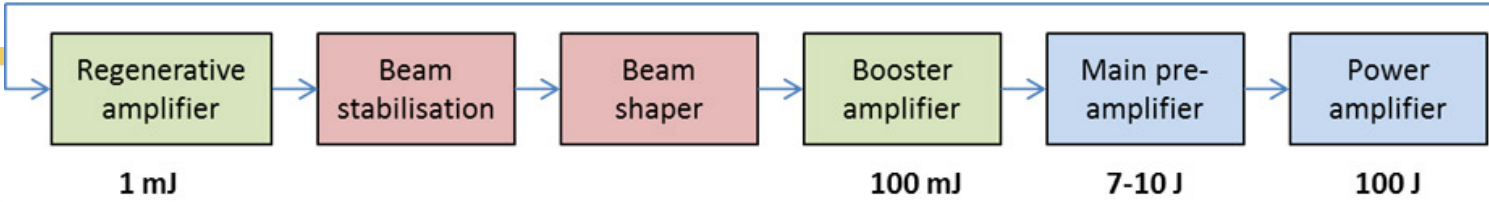
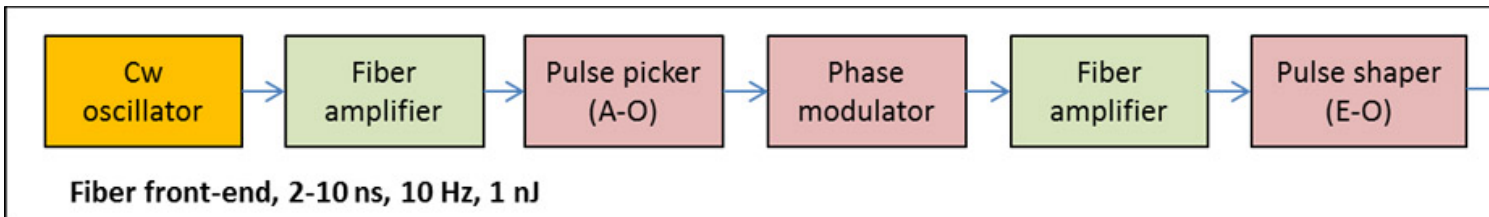
## Development of 100 J / 10 Hz cryogenically cooled multi-slab DPSSL system scalable to kJ level (L2)



# Strategic partnership with STFC/RAL



D1	✓
D2	✓
D3	✓
D4	✓
D5	✓
D6	✓
D7	
D8	
D9	
D10	
D11	
D12	
D13	

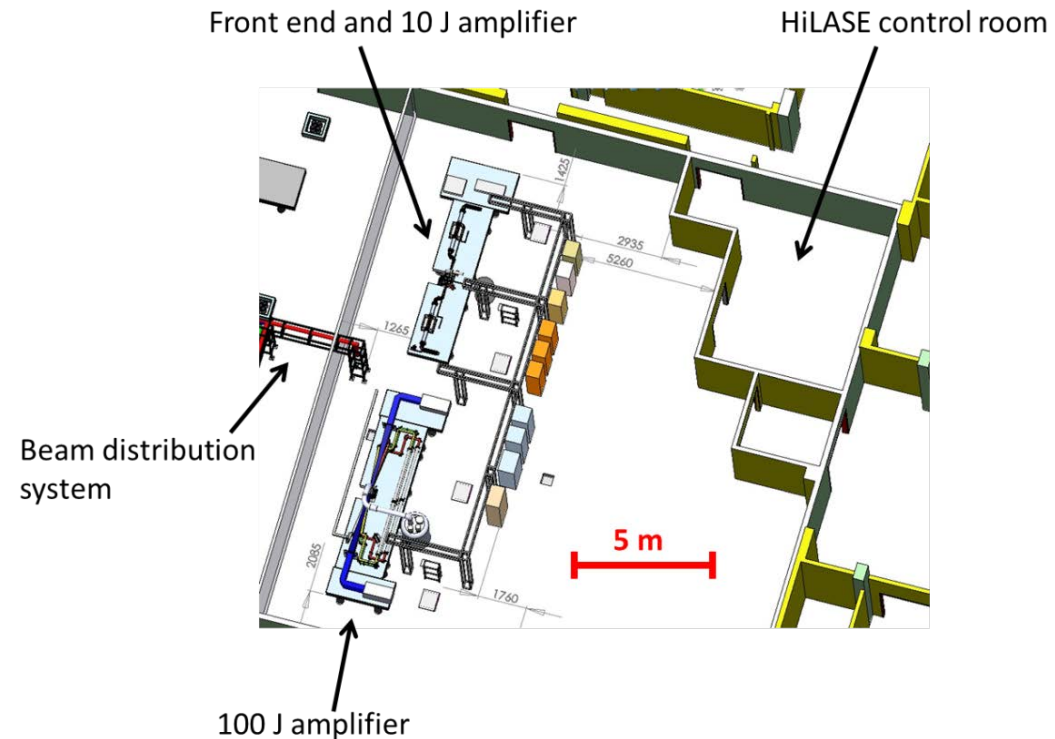




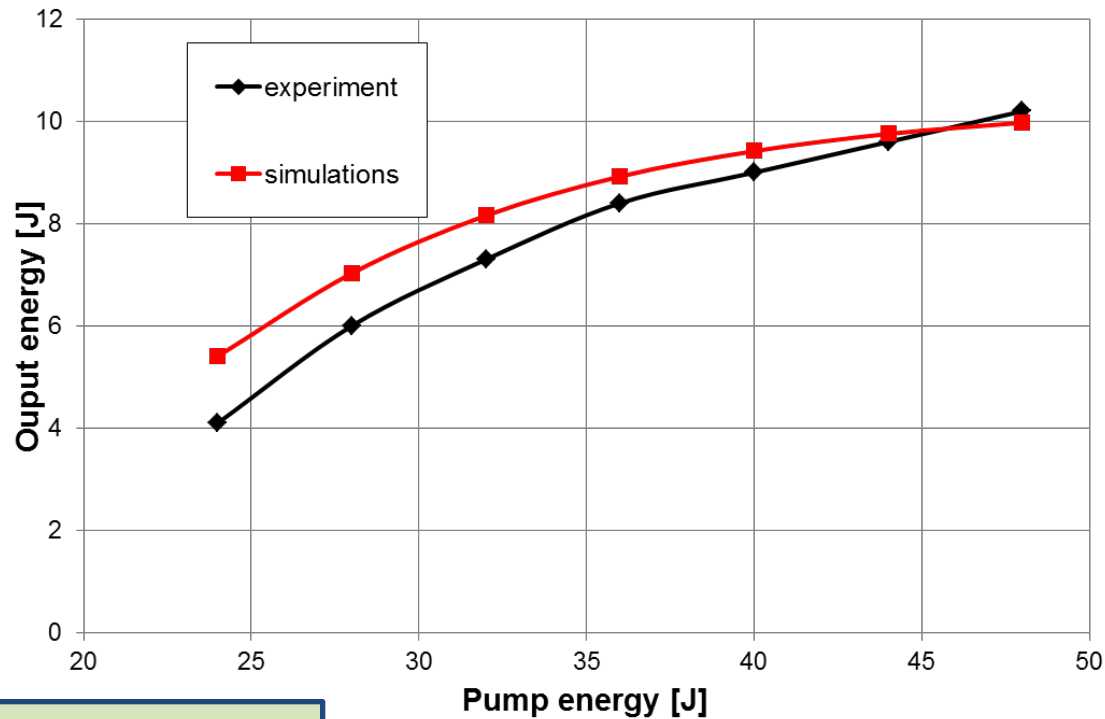
# Beamline L2 under construction



Parameter	Specification
Pulse energy	> 100 J
Av. output power	> 1 kW
Pulse length	2-10 ns
Pulse shape	Programmable (150 ps steps)
Repetition rate	1 – 10 Hz
Output beam size	75mm*75mm (SG order > 8)
RMS modulation	< 1%
Wavefront quality	$\lambda/10$
E-o efficiency	> 12 %

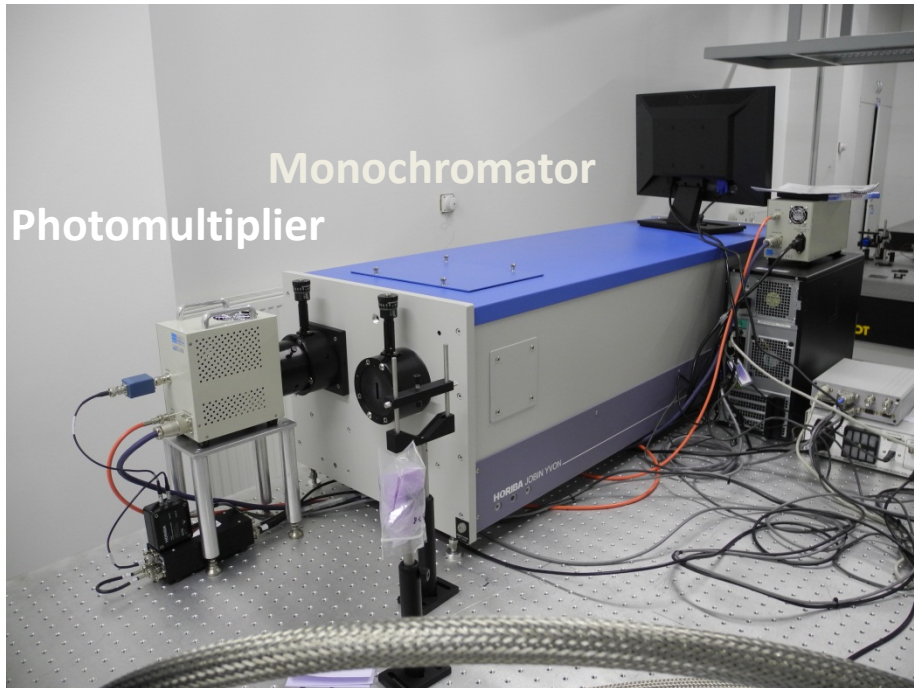


# 10J/10Hz operation demonstrated



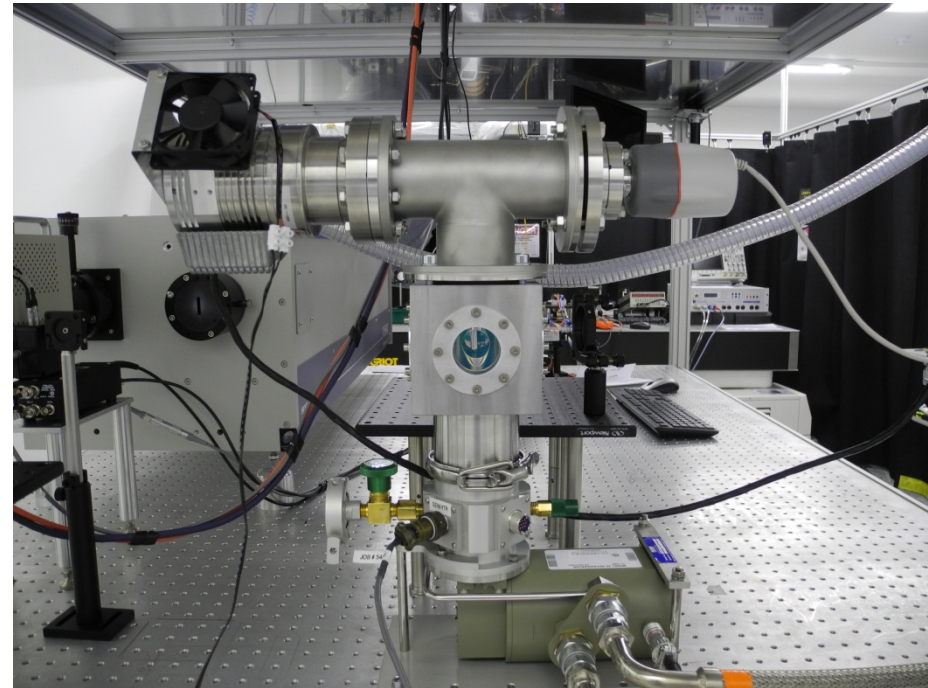
- Pump power: 2 x 20 kW
- Pump duration: 1.2 ms
- Seed energy: 16 mJ

- > Temporally shaped pulse
- > Spatially modulated pulses



Monochromator

Photomultiplier

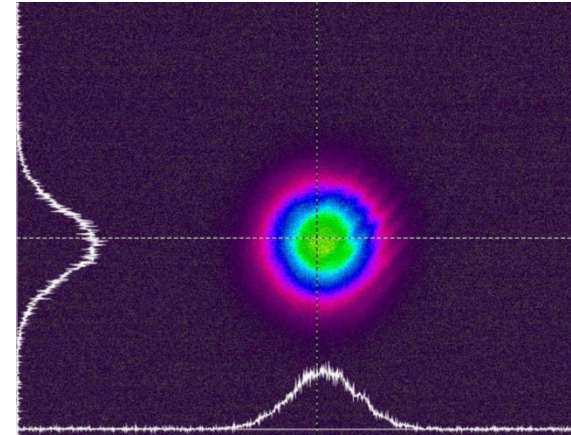
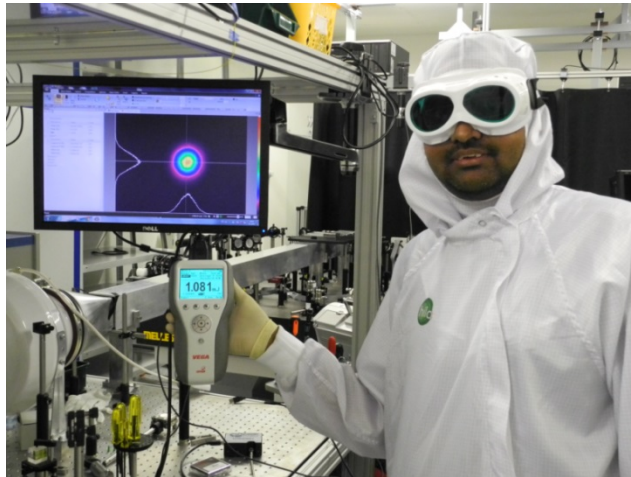


We plan to investigate Yb-doped materials:

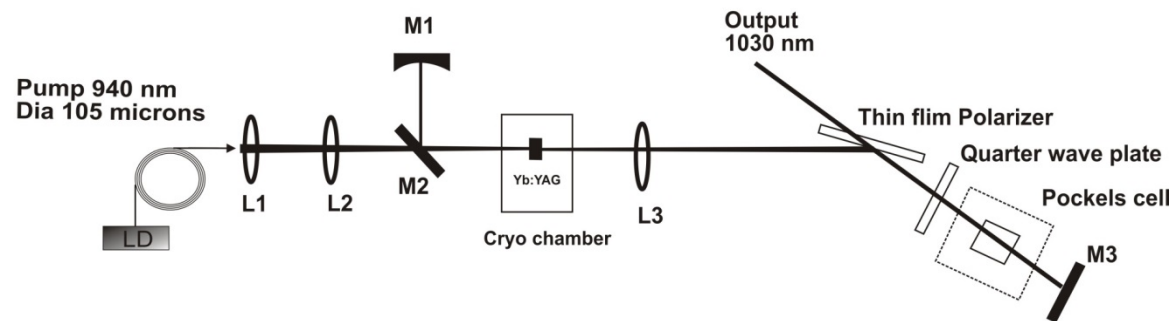
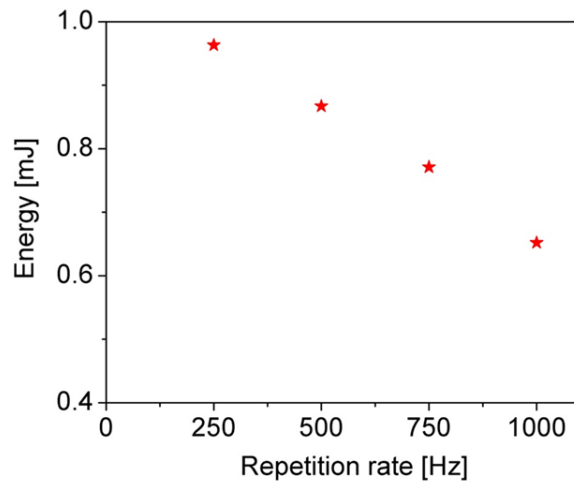
*Yb-doped silicate glasses,  
Yb:YAP, Yb:LuAG, Yb:CaF<sub>2</sub>,...*



# 40 ns cryo laser cavity for LIDT tests

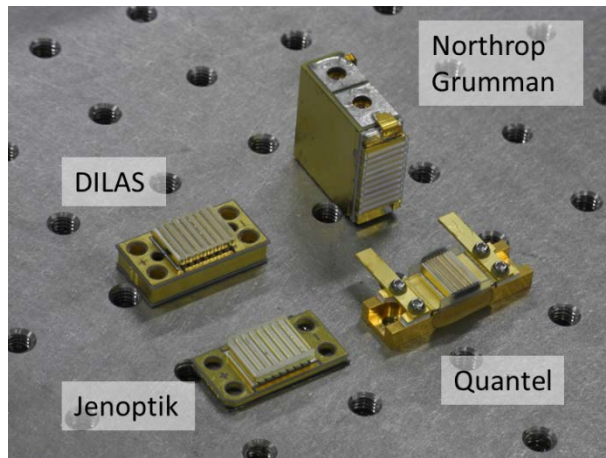


Cryo laser setup - Q-switching

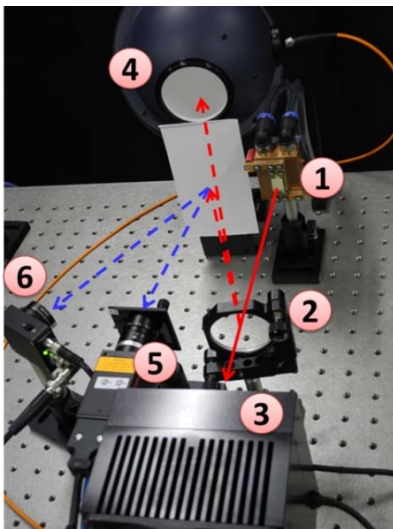


M1 - Concave mirror; M2 - Dichroic mirror; M3- Plane mirror; L3 - Plano convex lens

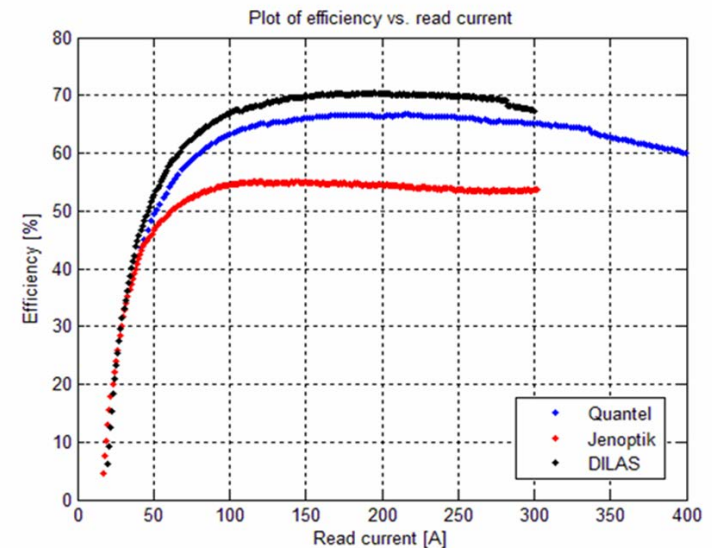
# Diode stacks characterization



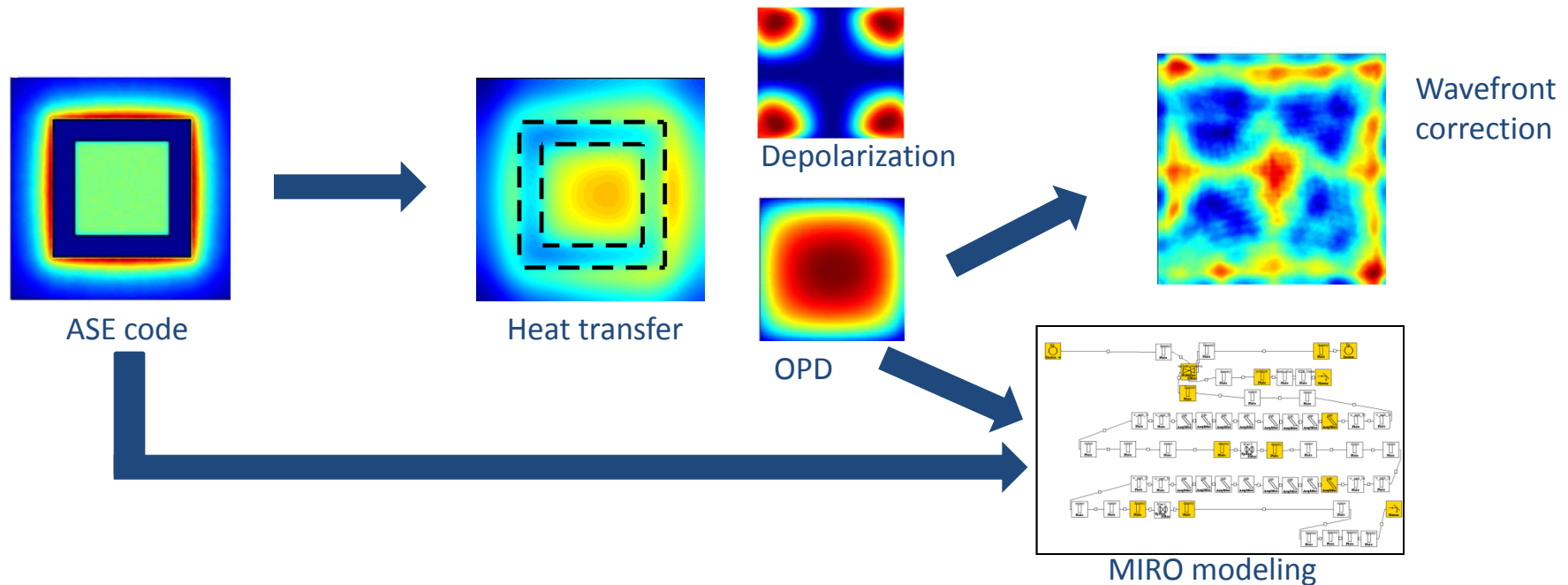
Parameters	QCW
Central wavelength	939 nm
Central wavelength tolerance	$\pm 2$ nm
Spectral width (FWHM)	< 5-6 nm
Repetition rate (f)	10 Hz
Pulse duration (t)	0.8-1.2 ms
Output power per stack	> 2500 W



- 1) Diode stack
- 2) Wedge prism
- 3) Power meter
- 4) Integration sphere
- 5) CCD camera with nd filter
- 6) Fast photodiode with nd filter

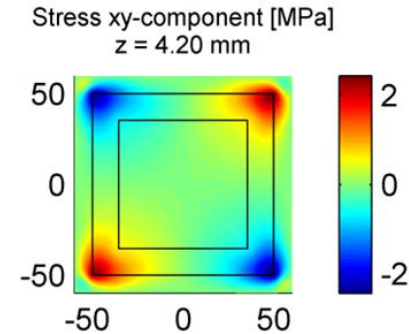
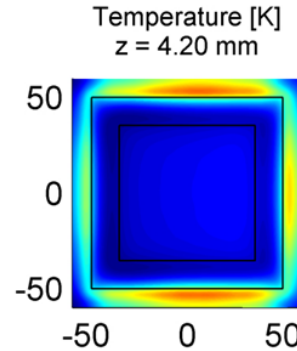
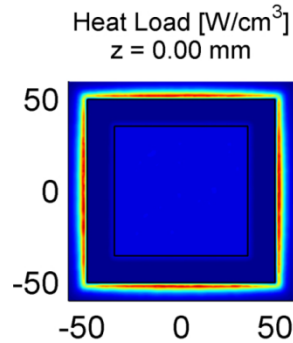
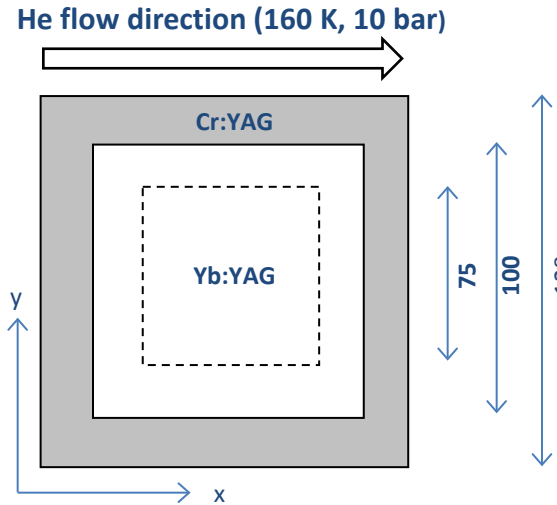


# Complex numerical modeling



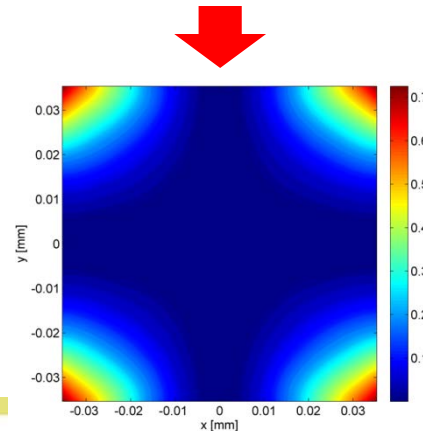
	Input	Calculation	Output	Responsible
1)	Pump beam, geometry	<b>ASE modeling</b>	stored energy, heat load	<b>Magda S.</b>
2)	Heat load	<b>Thermo-optical modeling</b>	OPD, depolarization	<b>Ondrej S.</b>
3)	OPD	<b>MIRO modeling</b>	Output beam profile	<b>Martin D.</b>
4)	OPD	<b>Wavefront correction</b>	AO performance, wavefront	<b>Jan P.</b>

# Thermo-optical modeling



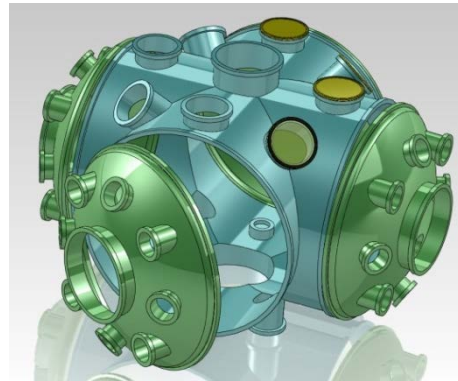
A.L. Bullington, S. B. Sutton, A. J. Bayramian, J. A. Caird, R. J. Deri, A. C. Erlandson, M. A. Henesian, "Thermal birefringence and depolarization compensation in glass-based high-average-power laser systems", Proc. SPIE, vol. 7916 (2011).

O. Slezak, A. Lucianetti, M. Divoky, M. Sawicka, and T. Mocek, "Optimization of Wavefront Distortions and Thermal-Stress Induced Birefringence in a Cryogenically-Cooled Multislab Laser Amplifier," *IEEE Journal of Quantum Electronics*, vol. 49, pp. 960-966, 2013.



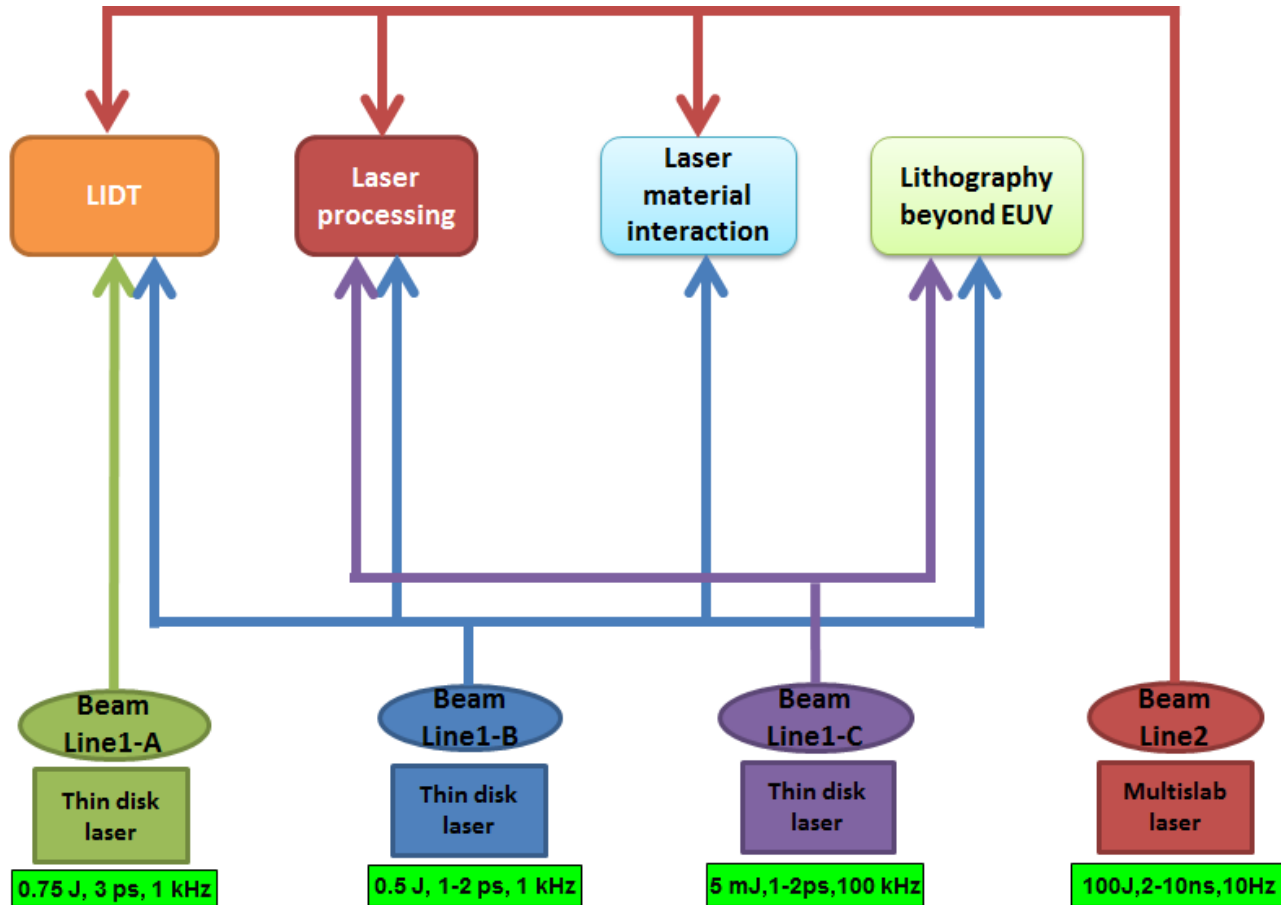
Average depolarization after 24 passes: 9.6 %

## Development of high-tech industrial and scientific applications

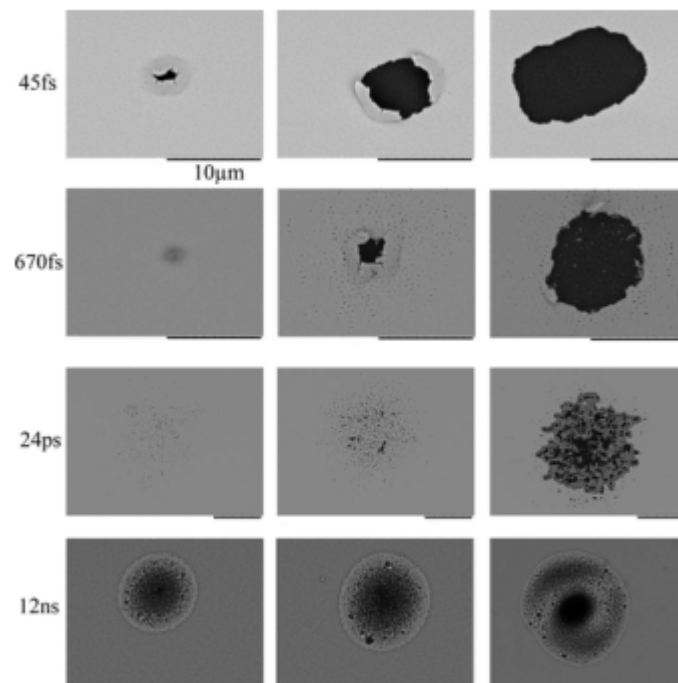




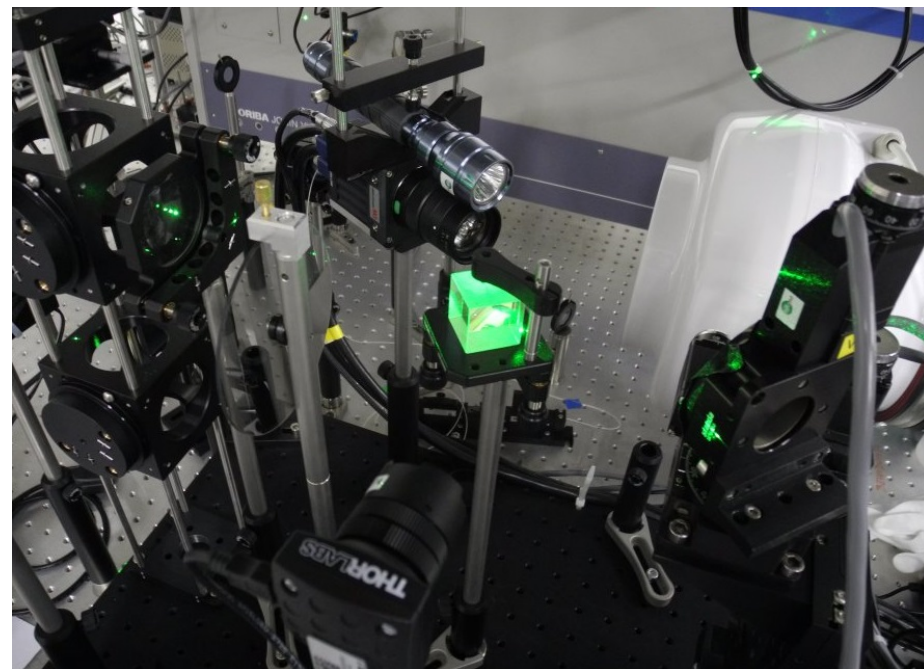
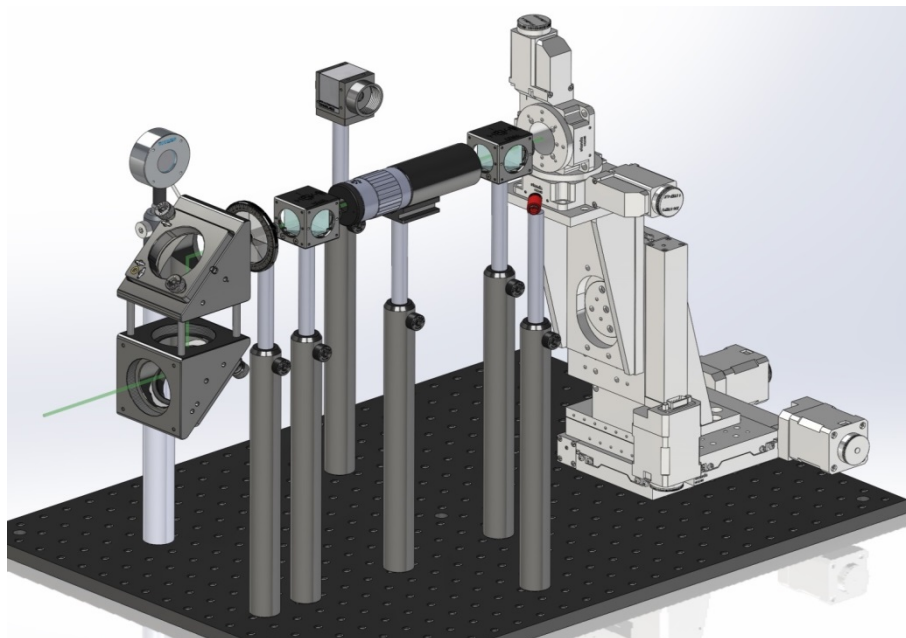
# Key R&D activities



# Laser Induced Damage Threshold (LIDT)

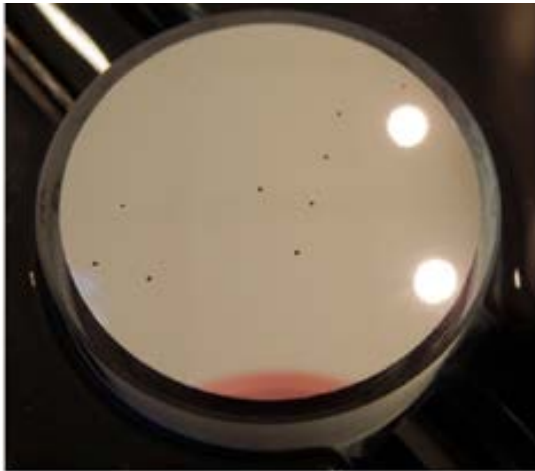


# LIDT test station

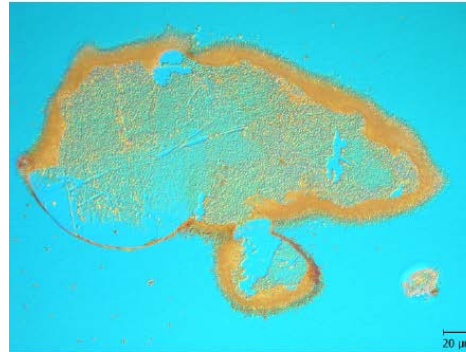


- 1: Attenuator
- 2: Beam focusing (2014)
- 3: Beam energy and beam
- 4: Scattering detection
- 5: XYZ motorized tower

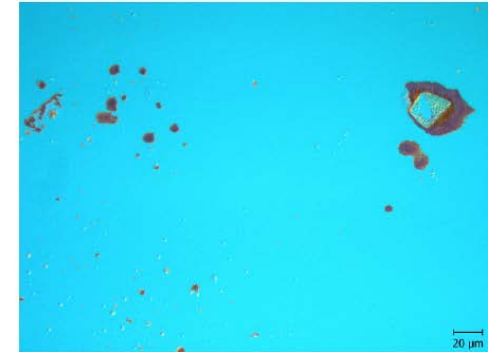




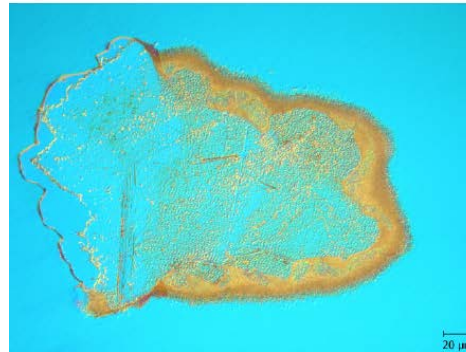
H011 spot 03



H011 spot 13



H014 spot 16



H014 spot 25



# Laser Shock Peening



## Shock Peening

In the process of establishing cooperation with:

- Prof. Ocaña (Centro Láser UPM, Madrid, Spain)
- Dr. Alessandro Fortunato (Alma Mater University, Bologna )
- Dr. Alessandro Candiani (University of Parma)

“HiLASE multi-slab laser system:  
a tool for efficient peening”  
4th International Conference  
on Laser Peening and Related  
Phenomena Proc. Book, to be  
published



Roman and Danijela visiting Prof. Ocaña - November 2013

# Cooperation with Industry



## LIDT:



**MELLES GRIOT**



**CORNING**

## LSP and processing :



ŠKODA



**Honeywell**



## Surface modifications



# Cooperation with Industry



## Laser vendors

- Process development
- Popularization of lasers
- Marketing

**OMRON**

**TRUMPF**

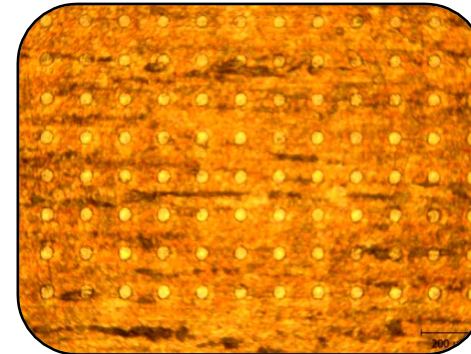
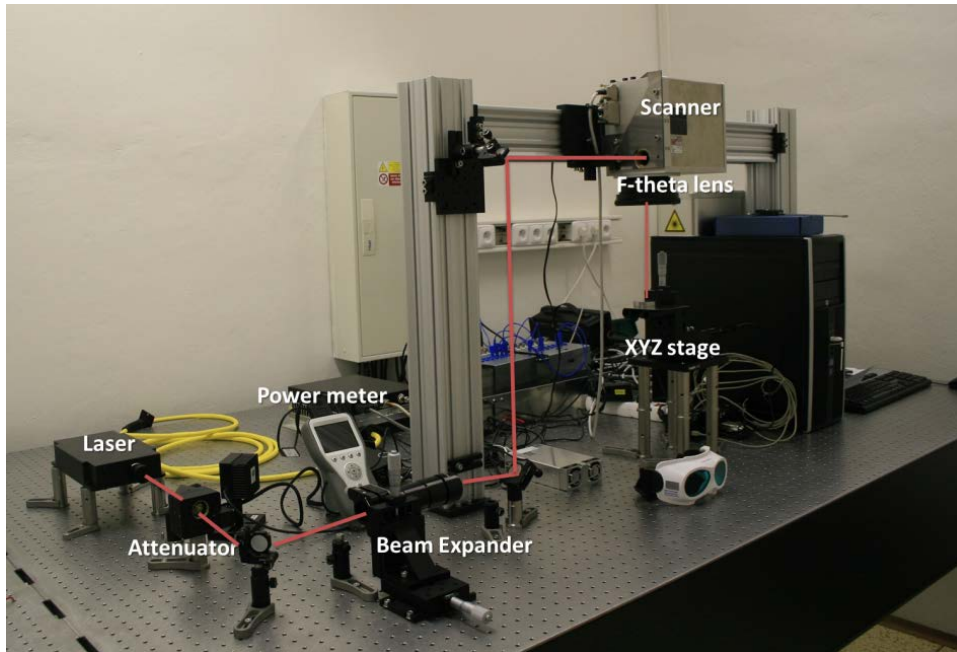


## Laser end-users

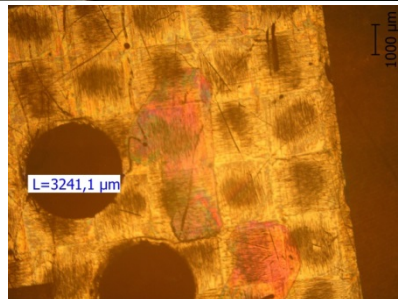
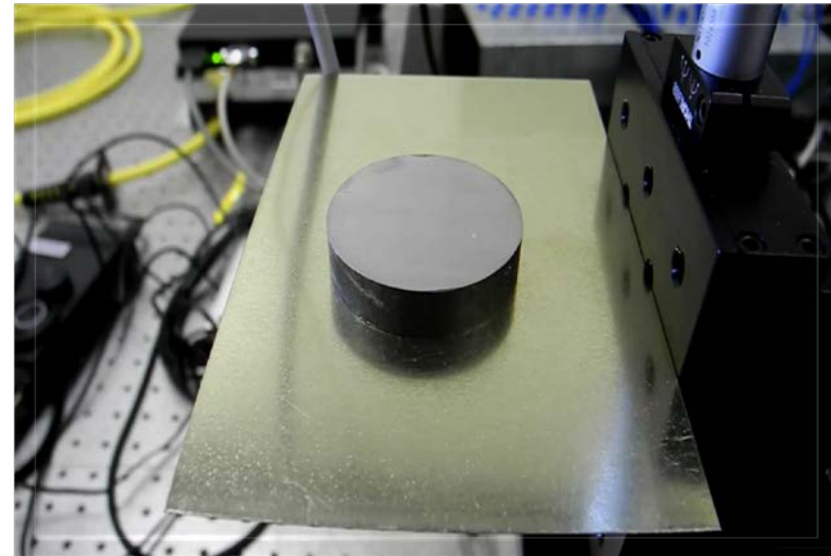
- Safety training and education
- Process development
- Existing process improvement



# Laser $\mu$ -nano processing station



20-30  $\mu\text{m}$  holes  
In metals



Carbon Reinforced Plastics (CRFP), ITO thin films, ...





# Keeping the Team Spirit



[www.hilase.cz/en](http://www.hilase.cz/en)

[hilase@fzu.cz](mailto:hilase@fzu.cz)

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